

CDC6Cx Low Power LVCMOS Output BAW Oscillator

1 Features

- LVCMOS output oscillator supporting frequency range from 250kHz to 200MHz
- ±25ppm total frequency stability inclusive of all factors and including 10 years aging
- Supply voltage supports 1.8V to 3.3V ±10%.
- Very low power consumption: 4.32mA typical and 7.4mA maximum for 25MHz at 1.8V
- Stand by current 1.5µA typical at 1.8V helps for battery powered applications
- Low jitter: < 1ps RMS jitter for $F_{out} \geq 10\text{MHz}$
- Smallest industry standard package: 1.60mm × 1.2mm (DLY), 2.00mm × 1.60mm (DLX), 2.50mm × 2.00mm (DLF), 3.20mm × 2.5mm (DLE)
 - Universal land pattern footprint under *Mechanical, Packaging, and Orderable Information*
- Operating temperature range: –40°C to +105°C
- Integrated LDO for robust supply noise immunity
- Start-up time < 3ms
 - Contact TI for different start-up times.
- Orderable options for slow rise and fall time for EMI reduction
- Supported frequencies (MHz):
 - 1.2, 2.048, 4, 5.12, 6.78, 8, 8.192, 10, 12, 12.288, 16, 19.2, 20, 24, 24.576, 25, 26, 27, 30, 33.33, 33.333, 38.4, 40, 48, 50, 66.666, 76.8, 100, 125, 156.25, and more
- Contact TI representative for any frequency and samples needed.

2 Applications

- Crystal oscillator replacement
- [Data centers, Server, Storage](#)
- Ethernet, SAS, SATA, USB, WIFI
- [Wireless Communication](#)
- [Professional audio/video](#)
- [Factory Automation and Control](#)
- [Personal Electronics, Wearable devices, IoT](#)
- FPGA, MCU, Processor and ASIC clocking

3 Description

Texas Instruments' high-precision Bulk-Acoustic Wave (BAW) micro-resonator technology is integrated directly into a package allowing for low jitter clock circuitry. BAW is fully designed and manufactured at TI factories like other silicon-based fabrication processes.

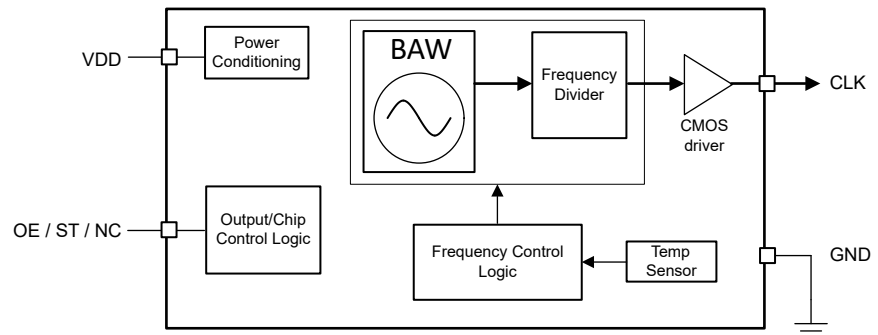
The CDC6Cx device is a low jitter, low power, fixed-frequency oscillator which incorporates the BAW as the resonator source. The device is factory-programmed per specific frequency and function pin. With a frequency control logic and output frequency divider, the CDC6Cx is capable of producing any frequency within the specified range providing a single device family for all frequency needs.

The high-performance clocking, mechanical stability, lower power consumption, flexibility, and small package options for this device are designed for reference clock and core clocks in Industrial, Telecom, Data and Enterprise Network and Personal Electronics end equipments.

Packaging Information

| PART NUMBER | OUTPUT TYPE | PACKAGE ⁽¹⁾ | PACKAGE SIZE ⁽²⁾ |
|-------------|-------------|------------------------|-----------------------------|
| CDC6Cx | LVCMOS | VSON (DLE-4) | 3.20mm × 2.50mm |
| | | VSON (DLF-4) | 2.50mm × 2.00mm |
| | | VSON (DLX-4) | 2.00mm × 1.60mm |
| | | VSON (DLY-4) | 1.60mm × 1.20mm |

- (1) For more information, see [Mechanical, Packaging, and Orderable Information](#).
- (2) The package size (length × width) is a nominal value and includes pins, where applicable.



CDC6Cx Simplified Block Diagram

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4 Device Comparison

Use the [CDC6C OPN Decoder](#) to understand the device nomenclature of the CDC6Cx orderable options. The [CDC6C OPN Decoder](#) provides a quick summary of how to decode the frequency, package information and a list of the CDC6Cx orderable part numbers (OPNs) with associated configurations, packaging information, and device top marking.

[Section 8.3.5.1](#) explains the different normal and slow mode options and [Section 8.3.3](#) explains stand by and output enable options.

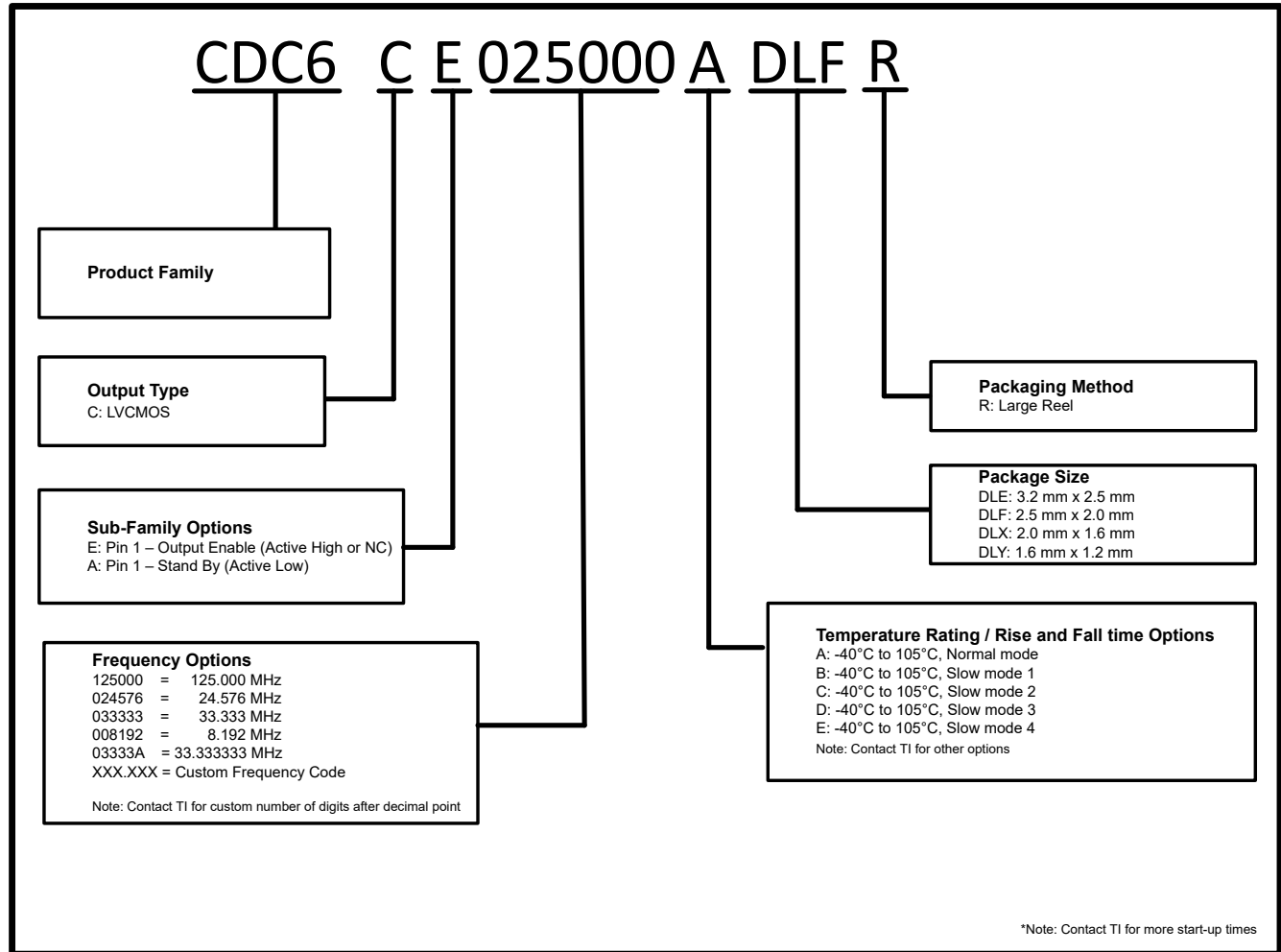


Figure 4-1. Part Number Guide: CDC6Cx

Note: Contact a TI representative to pre-order specific devices. Email: ti_osc_customer_requirement@list.ti.com

5 Pin Configuration and Functions

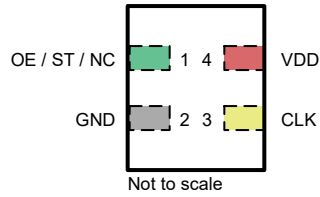


Figure 5-1. CDC6Cx 4-Pin VSON (Top View)

| Legend | |
|--------|--------|
| Input | Power |
| Ground | Output |

Table 5-1. CDC6Cx Pin Functions

| PIN | | Type ⁽¹⁾ | DESCRIPTION |
|--------------|-----|---------------------|--|
| NAME | NO. | | |
| OE / ST / NC | 1 | I / NC | Output Enable (OE) or Stand By (ST) pin on No Connect (NC). See the <i>Function Pin Descriptions</i> for more details. |
| GND | 2 | G | Device ground |
| CLK | 3 | O | LVC MOS output clock |
| VDD | 4 | P | Device power supply |

(1) I = Input, O = Output, I/O = Input or Output, G = Ground, P = Power, NC = No Connect (can be left floating).

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)⁽¹⁾

| | | MIN | MAX | UNIT |
|------------------|--------------------------------------|------|------|------|
| V _{DD} | Device supply voltage ⁽²⁾ | -0.3 | 3.63 | V |
| EN | Logic input voltage | -0.3 | 3.63 | V |
| CLK | Clock output voltage | -0.3 | 3.63 | V |
| T _J | Junction temperature | | 130 | °C |
| T _{STG} | Storage temperature | -65 | 150 | °C |

- (1) Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) For all devices with the recommended operating voltage of 1.8V ±10%, 2.5V ±10% and 3.3V ±10%

6.2 ESD Ratings

| | | | VALUE | UNIT |
|--------------------|-------------------------|---|-------|------|
| V _(ESD) | Electrostatic discharge | Human-body model (HBM), per AEC Q100-002, HBM ESD Classification Level 2 | ±2000 | V |
| V _(ESD) | Electrostatic discharge | Charged-device model (CDM), per AEC Q100-011 CDM ESD Classification Level C4A | ±750 | V |

6.3 Environmental Compliance

| | | VALUE | UNIT |
|----------------------------------|--|-------|------|
| Mechanical Vibration Resistance | MIL-STD-883F, Method 2026, Condition C | 10 | g |
| Mechanical Vibration Resistance | MIL-STD-883F, Method 2007, Condition A | 20 | g |
| Mechanical Shock Resistance | MIL-STD-883F, Method 2002, Condition A | 1500 | g |
| Moisture Sensitivity Level (MSL) | | MSL1 | |

6.4 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| | | MIN | NOM | MAX | UNIT |
|-------------------|---|------|---------------|------|------|
| V _{DD} | Device supply voltage ⁽¹⁾ | 1.62 | 1.8, 2.5, 3.3 | 3.63 | V |
| T _A | Ambient temperature | -40 | | 105 | °C |
| T _J | Junction temperature | | | 130 | °C |
| t _{RAMP} | V _{DD} power-up ramp time ⁽²⁾ | 0.1 | | 100 | ms |

- (1) For all devices with the recommended operating voltage of 1.8V ±10%, 2.5V ±10% and 3.3V ±10%
- (2) V_{DD} power-up ramp time is defined as minimum time taken for power supply to exceed 95% of nominal VDD. Monotonic power supply ramp is assumed.

6.5 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | CDC6C | | | | UNIT |
|-------------------------------|--|-------|-------|-------|-------|------|
| | | DLE | DLF | DLX | DLY | |
| | | 4 | 4 | 4 | 4 | |
| R _{θJA} | Junction-to-ambient thermal resistance | 151.8 | 151.7 | 180.3 | 189.1 | °C/W |
| R _{θJC(top)} | Junction-to-case (top) thermal resistance | 89.5 | 99.3 | 116.2 | 137.3 | °C/W |
| R _{θJB} | Junction-to-board thermal resistance | 72.2 | 64.4 | 85.5 | 85 | °C/W |
| Ψ _{JT} | Junction-to-top characterization parameter | 11.1 | 9.2 | 8.5 | 6.2 | °C/W |
| Ψ _{JB} | Junction-to-board characterization parameter | 71.2 | 63.5 | 83.7 | 83.2 | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.

6.6 Electrical Characteristics

over the recommended operating conditions (V_{DD} = 1.8V ± 10%, 2.5V ± 10%, 3.3V ± 10%; typical values are at 25°C unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|--|-----|------|------|------|
| Current Consumption Characteristics | | | | | | |
| I _{DD} | Device current consumption (excluding load current) | –40°C to 85°C, F _{out} = 20 MHz, V _{dd} = 1.8V±10% | | 4.22 | 6.7 | mA |
| | | –40°C to 85°C, F _{out} = 20 MHz, V _{dd} = 3.3V±10% | | 4.41 | 6.7 | mA |
| | | –40°C to 105°C, F _{out} = 20 MHz, V _{dd} = 1.8V±10% | | 4.22 | 7.3 | mA |
| | | –40°C to 105°C, F _{out} = 20 MHz, V _{dd} = 3.3V±10% | | 4.41 | 7.3 | mA |
| I _{DD} | Device current consumption (excluding load current) | –40°C to 85°C, F _{out} = 25 MHz, V _{dd} = 1.8V±10% | | 4.32 | 6.8 | mA |
| | | –40°C to 85°C, F _{out} = 25 MHz, V _{dd} = 3.3V±10% | | 4.57 | 6.9 | mA |
| | | –40°C to 105°C, F _{out} = 25 MHz, V _{dd} = 1.8V±10% | | 4.32 | 7.4 | mA |
| | | –40°C to 105°C, F _{out} = 25 MHz, V _{dd} = 3.3V±10% | | 4.57 | 7.5 | mA |
| I _{DD} | Device current consumption (excluding load current) | –40°C to 85°C, F _{out} = 50 MHz, V _{dd} = 1.8V±10% | | 4.84 | 7.1 | mA |
| | | –40°C to 85°C, F _{out} = 50 MHz, V _{dd} = 3.3V±10% | | 5.33 | 7.2 | mA |
| | | –40°C to 105°C, F _{out} = 50 MHz, V _{dd} = 1.8V±10% | | 4.84 | 7.6 | mA |
| | | –40°C to 105°C, F _{out} = 50 MHz, V _{dd} = 3.3V±10% | | 5.33 | 7.8 | mA |
| I _{DD} | Device current consumption (excluding load current) | –40°C to 85°C, F _{out} = 100 MHz, V _{dd} = 1.8V±10% | | 5.86 | 7.6 | mA |
| | | –40°C to 85°C, F _{out} = 100 MHz, V _{dd} = 3.3V±10% | | 6.77 | 9.0 | mA |
| | | –40°C to 105°C, F _{out} = 100 MHz, V _{dd} = 1.8V±10% | | 5.86 | 8.2 | mA |
| | | –40°C to 105°C, F _{out} = 100 MHz, V _{dd} = 3.3V±10% | | 6.77 | 9.0 | mA |
| I _{DD} | Device current consumption (excluding load current) | –40°C to 85°C, F _{out} = 150 MHz, V _{dd} = 1.8V±10% | | 7.14 | 9.5 | mA |
| | | –40°C to 85°C, F _{out} = 150 MHz, V _{dd} = 3.3V±10% | | 8.72 | 11.0 | mA |
| | | –40°C to 105°C, F _{out} = 150 MHz, V _{dd} = 1.8V±10% | | 7.14 | 9.5 | mA |
| | | –40°C to 105°C, F _{out} = 150 MHz, V _{dd} = 3.3V±10% | | 8.72 | 11.0 | mA |
| I _{DD_stdby} | Device standby current | –40°C to 85°C, ST = GND, V _{dd} =1.8V±10% | | 1.5 | | μA |
| | | –40°C to 85°C, ST = GND, V _{dd} =2.5V±10% | | 2 | | μA |
| | | –40°C to 85°C, ST = GND, V _{dd} =3.3V±10% | | 2.7 | | μA |
| | | –40°C to 105°C, ST = GND, V _{dd} =1.8V±10% | | 1.5 | | μA |
| | | –40°C to 105°C, ST = GND, V _{dd} =2.5V±10% | | 2 | | μA |
| | | –40°C to 105°C, ST = GND, V _{dd} =3.3V±10% | | 2.7 | | μA |
| I _{DD-OD} | Device current with output disabled | –40°C to 85°C, F _{out} = 25 MHz, V _{dd} = 1.8V±10% | | 3.75 | 6.4 | mA |
| | | –40°C to 85°C, F _{out} = 25 MHz, V _{dd} = 3.3V±10% | | 3.76 | 6.5 | mA |
| | | –40°C to 105°C, F _{out} = 25 MHz, V _{dd} = 1.8V±10% | | 3.75 | 7 | mA |
| | | –40°C to 105°C, F _{out} = 25 MHz, V _{dd} = 3.3V±10% | | 3.76 | 7.1 | mA |

6.6 Electrical Characteristics (continued)

over the recommended operating conditions ($V_{DD} = 1.8V \pm 10\%$, $2.5V \pm 10\%$, $3.3V \pm 10\%$; typical values are at $25^\circ C$ unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|---|------|----------------------|-------|----------|
| Output Characteristics | | | | | | |
| F_{out} | Output frequency | | 0.25 | | 200 | MHz |
| V_{OL} | Output low voltage | $I_{OL} = 3.6mA$, $V_{DD} = 1.8V$ | | | 0.36 | V |
| | | $I_{OL} = 5.0mA$, $V_{DD} = 2.5V$ | | | 0.5 | V |
| | | $I_{OL} = 6.6mA$, $V_{DD} = 3.3V$ | | | 0.66 | V |
| V_{OH} | Output high voltage | $I_{OH} = 3.6mA$, $V_{DD} = 1.8V$ | | $V_{DD} \times 0.88$ | | V |
| | | $I_{OH} = 5.0mA$, $V_{DD} = 2.5V$ | | $V_{DD} \times 0.85$ | | V |
| | | $I_{OH} = 6.6mA$, $V_{DD} = 3.3V$ | | $V_{DD} \times 0.85$ | | V |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 2pF$, normal mode, $F_{out} = 25MHz$ | | 0.28 | 0.65 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 2pF$, slow mode 1, $F_{out} = 25MHz$ | | 0.42 | 0.75 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 5pF$, normal mode, $F_{out} = 25MHz$ | | 0.33 | 0.8 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 5pF$, slow mode 2, $F_{out} = 25MHz$ | | 1.11 | 2.0 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 10pF$, normal mode, $F_{out} = 25MHz$ | | 0.44 | 1.7 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 10pF$, slow mode 3, $F_{out} = 25MHz$ | | 1.85 | 3.1 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 15pF$, normal mode, $F_{out} = 25MHz$ | | 0.87 | 2.2 | ns |
| t_R/t_F | Output rise/fall time | 20% to 80% of $V_{OH} - V_{OL}$, $C_L = 15pF$, slow mode 4, $F_{out} = 25MHz$ | | 2.7 | 4.0 | ns |
| t_R/t_F | Output rise/fall time | 10% to 90% of $V_{OH} - V_{OL}$, no load, normal mode, $F_{out} = 25MHz$ | | 0.42 | | ns |
| t_R/t_F | Output rise/fall time | 10% to 90% of $V_{OH} - V_{OL}$, $C_L = 15pF$, normal mode, $F_{out} = 25MHz$ | | 2.05 | | ns |
| t_R/t_F | Output rise/fall time | 10% to 90% of $V_{OH} - V_{OL}$, $C_L = 15pF$, slow mode 4, $F_{out} = 25MHz$ | | 3.81 | | ns |
| ODC | Output duty cycle | | 45 | 50 | 55 | % |
| PN-Floor | Output phase noise floor ($f_{OFFSET} > 10MHz$) | $F_{out} = 50MHz$ | | -155 | | dBc/Hz |
| C_L | Maximum capacitive load | $F_{out} < 50MHz$ | | | 30 | pF |
| C_L | | $F_{out} > 50MHz$ | | | 15 | pF |
| $R_{out-high}$ | Output impedance | | | 50 | | Ω |
| Function Pin Characteristics (OE/ST) | | | | | | |
| V_{IL} | Input low voltage | $V_{DD} = 1.8V$ | | | 0.45 | V |
| | | $V_{DD} = 2.5V$ | | | 0.475 | V |
| | | $V_{DD} = 3.3V$ | | | 0.5 | V |
| V_{IH} | Input high voltage | | 1.3 | | | V |
| I_{IL} | Input low current | $EN = GND$ | -70 | | | μA |
| I_{IH} | Input high current | $EN = V_{DD}$ | | | 40 | μA |
| C_{IN} | Input capacitance ⁽¹⁾ | | | 2 | | pF |
| Frequency Tolerance | | | | | | |

6.6 Electrical Characteristics (continued)

over the recommended operating conditions ($V_{DD} = 1.8V \pm 10\%$, $2.5V \pm 10\%$, $3.3V \pm 10\%$; typical values are at 25°C unless otherwise noted)

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------------------------|---|--|-----|-----|----------|--------|
| F_T | Total frequency stability | Inclusive of: solder shift, initial tolerance, variation over -40°C to 105°C , variation over supply voltage range, and 10 years aging at 25°C . | | | ± 25 | ppm |
| F_T | Total frequency stability | Inclusive of: solder shift, initial tolerance, variation over -40°C to 105°C , variation over supply voltage range, and 1st year aging at 25°C . | | | ± 20 | ppm |
| F_T | Total frequency stability | Inclusive of: solder shift, initial tolerance, variation over -40°C to 85°C , variation over supply voltage range, and 10 years aging at 25°C . | | | ± 25 | ppm |
| F_T | Total frequency stability | Inclusive of: solder shift, initial tolerance, variation over -40°C to 85°C , variation over supply voltage range, and 1st year aging at 25°C . | | | ± 20 | ppm |
| PSRR Characteristics | | | | | | |
| PSRR | Spur induced by 50mV power supply ripple at 50MHz output, $V_{DD} = 2.5V/3.3V$, no power supply decoupling capacitor | Sine wave at 50kHz | | | -80 | dBc |
| | | Sine wave at 100kHz | | | -75 | dBc |
| | | Sine wave at 500kHz | | | -63 | dBc |
| | | Sine wave at 1MHz | | | -59 | dBc |
| Power-On Characteristics | | | | | | |
| $t_{\text{START_UP}}$ | Start-up time | Time elapsed from $0.95 \times V_{DD}$ until output is enabled and output is within specification. OE / ST = High; Tested with a power supply ramp time of $200\mu\text{s}$ | | 1.5 | 3 | ms |
| $t_{\text{ST-EN}}$ | Chip enable time | Time elapsed from standby ($ST = V_{IH}$) until output is enabled and output is within specification | | | 3 | ms |
| $t_{\text{ST-DIS}}$ | Chip disable time | Time elapsed from standby ($ST = V_{IL}$) until chip is in standby mode | | | 250 | ns |
| $t_{\text{OE-EN}}$ | Output enable time | Time elapsed from OE = V_{IH} until output is enabled and output is within specification | | | 250 | ns |
| $t_{\text{OE-DIS}}$ | Output disable Time | Time elapsed from OE = V_{IL} until output is disabled | | | 250 | ns |
| Clock Output Jitter | | | | | | |
| R_J | Random phase jitter | $10\text{MHz} \leq F_{\text{out}} \leq 40\text{MHz}$ (except 25MHz), integration BW: 12kHz to 5MHz, maximum temperature = 105°C | | 400 | 1000 | fs |
| R_J | Random phase jitter | $F_{\text{out}} = 25\text{MHz}$, integration BW: 12kHz to 20MHz, maximum temperature = 105°C | | 400 | 1000 | fs |
| R_J | Random phase jitter | $40\text{MHz} < F_{\text{out}} \leq 200\text{MHz}$, integration BW: 12kHz to 20MHz, maximum temperature = 105°C | | 400 | 1000 | fs |
| $\text{SPN}_{100\text{k}}$ | Spot phase noise at 1kHz offset | $F_{\text{out}} = 100\text{MHz}$ | | | -86 | dBc/Hz |
| $\text{SPN}_{100\text{k}}$ | Spot phase noise at 10kHz offset | $F_{\text{out}} = 100\text{MHz}$ | | | -120 | dBc/Hz |
| $\text{SPN}_{100\text{k}}$ | Spot phase noise at 100kHz offset | $F_{\text{out}} = 100\text{MHz}$ | | | -138 | dBc/Hz |
| $\text{SPN}_{1\text{M}}$ | Spot phase noise at 1MHz offset | $F_{\text{out}} = 100\text{MHz}$ | | | -143 | dBc/Hz |
| $R_{\text{JITT,RMS}}$ | RMS period jitter | $F_{\text{out}} \geq 25\text{MHz}$ | | 3 | | ps |
| $R_{\text{JITT,PK}}$ | Peak-peak period jitter | $F_{\text{out}} \geq 25\text{MHz}$ | | 26 | | ps |

(1) Proven by Design. Not characterised

6.7 Timing Diagrams

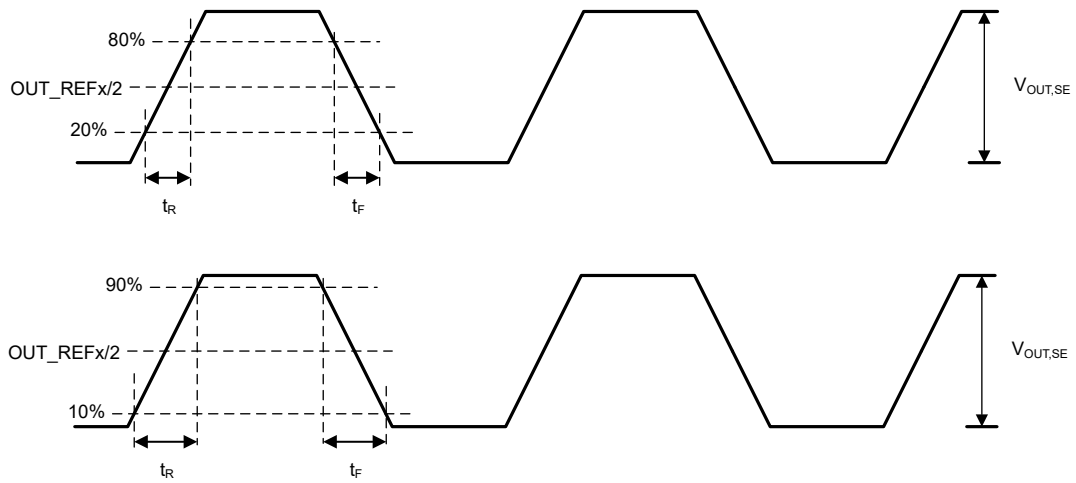


Figure 6-1. Single-Ended Output Voltage and Rise/Fall Time

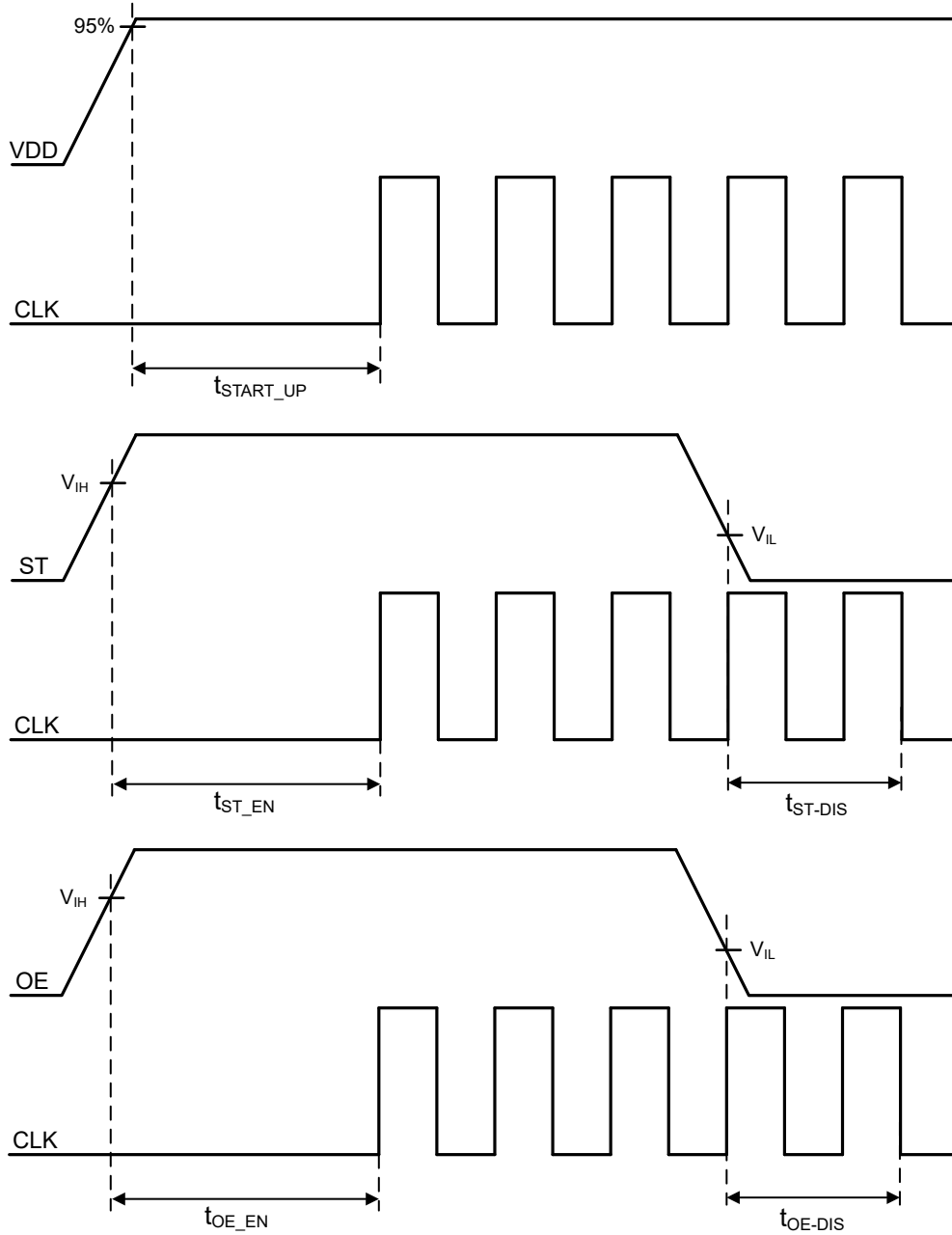


Figure 6-2. Power-On Characteristics

6.8 Typical Characteristics

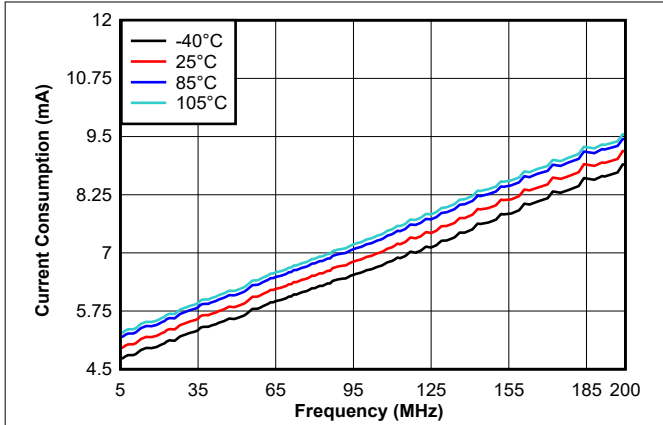


Figure 6-3. Current Consumption vs Frequency and Temperature at 1.8V Supply

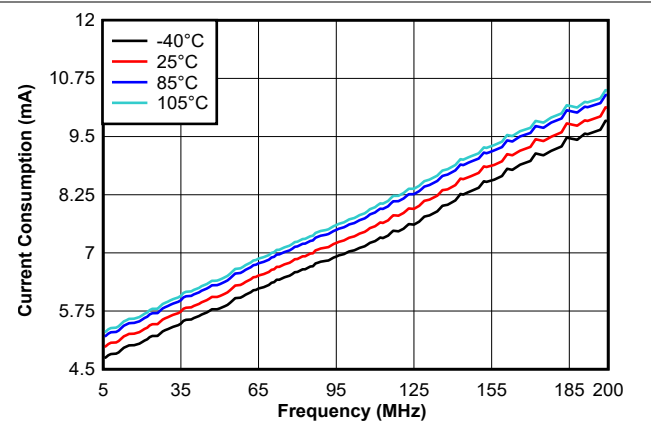


Figure 6-4. Current Consumption vs. Frequency and Temperature at 2.5V Supply

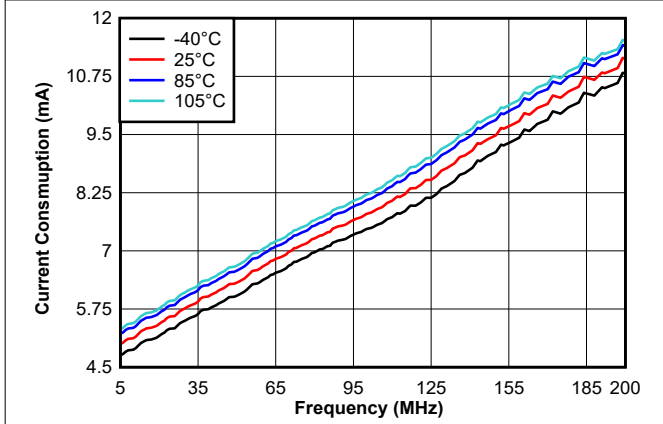


Figure 6-5. Current Consumption vs Frequency and Temperature at 3.3V Supply

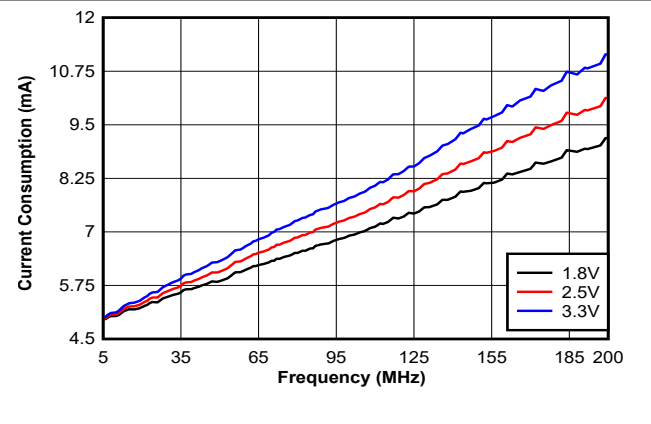


Figure 6-6. Current Consumption vs Frequency and Supply Voltage at 25°C

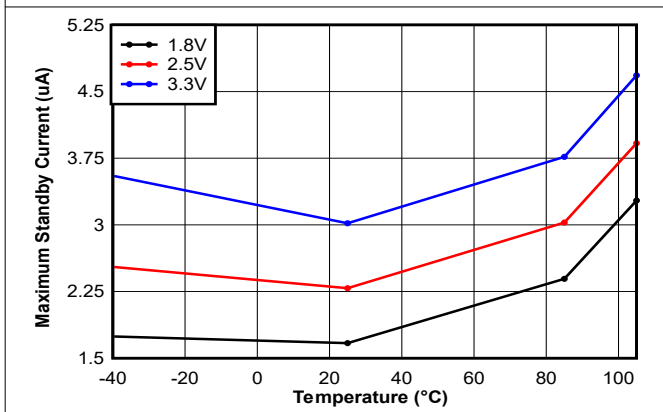


Figure 6-7. Maximum Standby Current vs Temperature and Supply Voltage

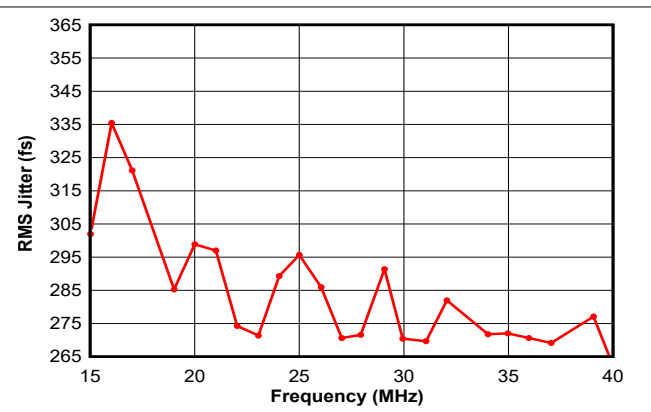


Figure 6-8. Typical RMS Jitter vs Frequency at 3.3V Supply and 25°C (BW 12kHz to 5MHz)

6.8 Typical Characteristics (continued)

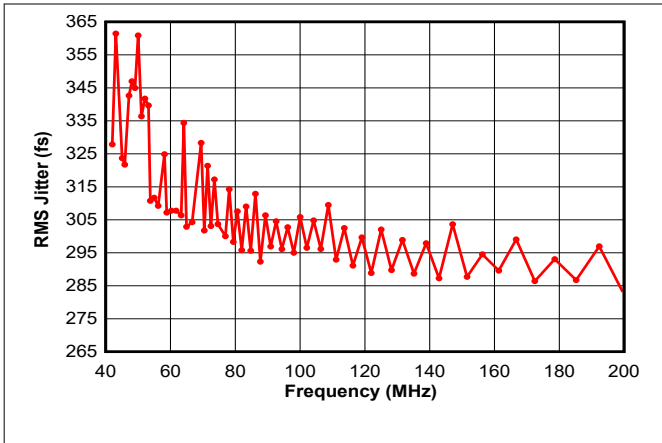


Figure 6-9. Typical RMS Jitter vs Frequency at 3.3V Supply and 25°C (BW 12kHz to 20MHz)

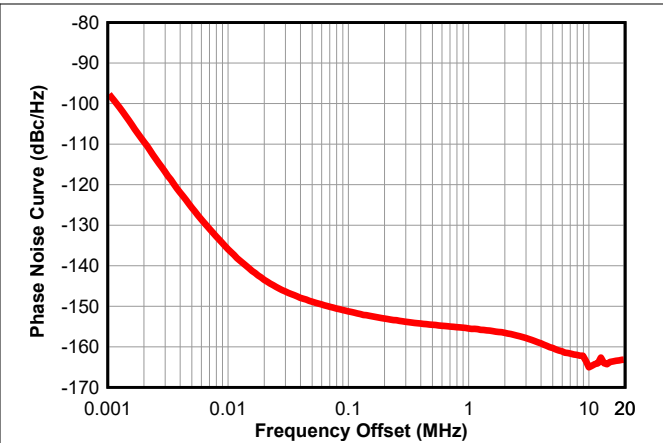


Figure 6-10. Phase Noise Curve at 25MHz, 25°C, and 3.3V Supply

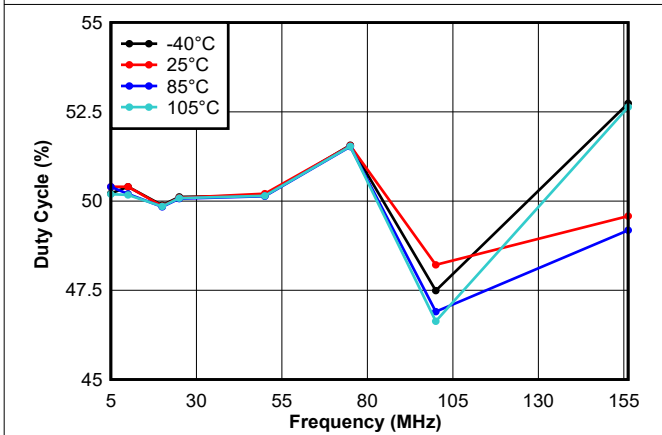


Figure 6-11. Duty Cycle vs Frequency and Temperature at 3.3V Supply, No Capacitive Load, Normal Mode Device

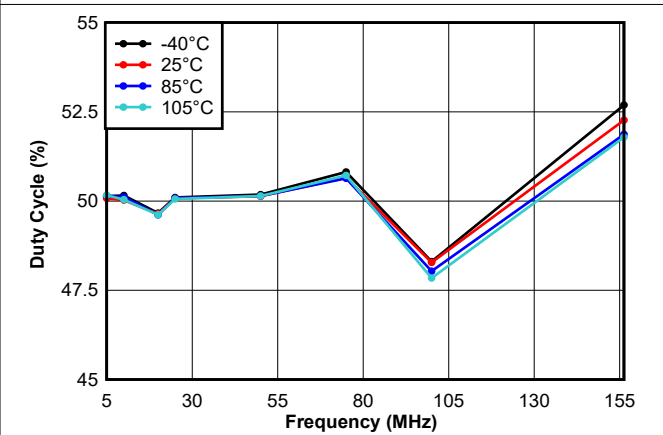
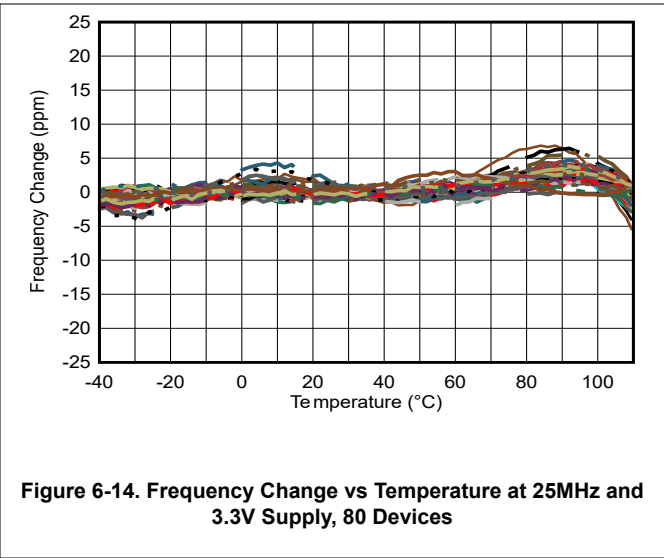
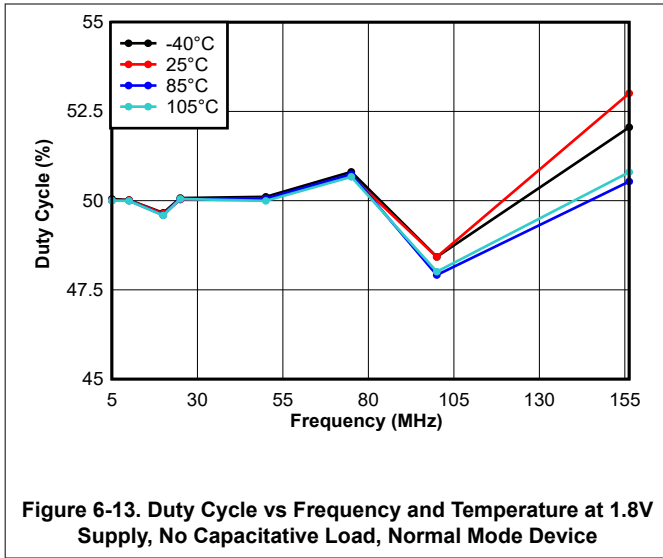


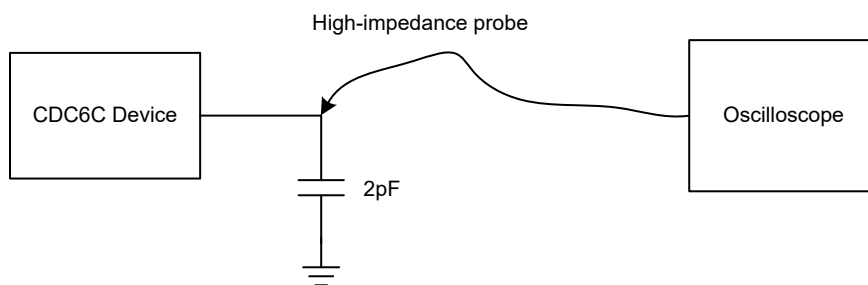
Figure 6-12. Duty Cycle vs Frequency and Temperature at 2.5V Supply, No Capacitive Load, Normal Mode Device

6.8 Typical Characteristics (continued)



7 Parameter Measurement Information

7.1 Device Output Configurations



Load capacitor modified based on measurement condition.

Figure 7-1. CDC6Cx Output Test Configuration

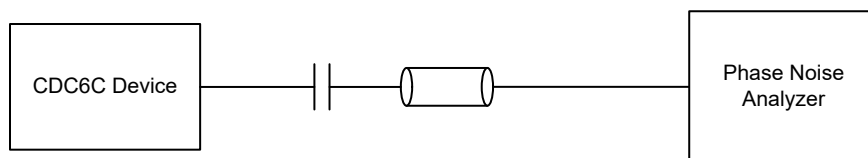


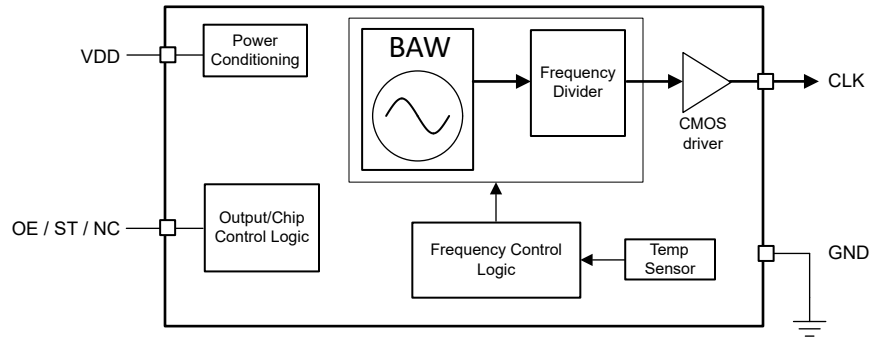
Figure 7-2. CDC6Cx Output Phase Noise Test Configuration

8 Detailed Description

8.1 Overview

The CDC6Cx is a fixed-frequency, BAW based oscillator that supports a CMOS output format within the range of 250kHz to 200MHz.

8.2 Functional Block Diagram



8.3 Feature Description

8.3.1 Bulk Acoustic Wave (BAW)

TI's BAW resonator technology uses piezoelectric transduction to generate high-Q resonance at 2.5GHz. The resonator is defined by the quadrilateral area overlaid by top and bottom electrodes. Alternating high-acoustic and low-acoustic impedance layers form acoustic mirrors beneath the resonant body to prevent acoustic energy leakage into the substrate. Furthermore, these acoustic mirrors are also placed on top of the resonator stack to protect the device from contamination and minimize energy leakage into the package materials. This unique dual-Bragg acoustic resonator (DBAR) allows efficient excitation without the need of costly vacuum cavities around the resonator. As a result, TI's BAW resonator is immune to frequency drift caused by absorption of surface contaminants and can be directly placed in a non-hermetic plastic package with the oscillator IC in small standard oscillator footprints.

8.3.2 Device Block-Level Description

The device contains a BAW oscillator, frequency integer divider, and CMOS driver which together generates a pre-programmed output frequency. Temperature variations of oscillation frequency are continuously monitored by internal precision temperature sensor and provided as input to the frequency control logic block. Using this Frequency Control Logic block, frequency corrections are performed internally for maintaining the output frequency within ± 25 ppm across temperature range and aging. The device contains an internal LDO which reduces the power supply noise, resulting in low noise clock output.

8.3.3 Function Pin

Pin 1 on the CDC6Cx is the function pin which have multiple functions based on the orderable part number. The function can be used as Output Enable (OE), Stand By (ST) or No Connect (NC). Options for both Active High and Active Low are available for OE and ST. Contact TI for Active Low options. *Function Pin Descriptions* table lists the functions of pin 1.

Table 8-1. Function Pin Descriptions for CDC6Cx

| ORDERABLE OPTION | PIN DESCRIPTION | OUTPUT FUNCTION |
|------------------|----------------------------------|---|
| E (Pin 1) | Output Enable (Active High / NC) | HIGH or No Connect : Output active at Specified Frequency LOW : Output disabled, high impedance; current consumption is given by I_{DD-OD} |

Table 8-1. Function Pin Descriptions for CDC6Cx (continued)

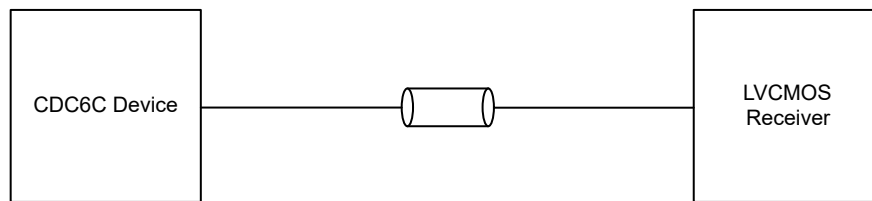
| ORDERABLE OPTION | PIN DESCRIPTION | OUTPUT FUNCTION |
|------------------|----------------------|--|
| A (Pin 1) | Standby (Active Low) | HIGH or No Connect: Output active at Specified Frequency LOW : High Impedance; standby mode; current consumption is given by standby current $I_{DD-stbby}$ |

In standby mode, all blocks are powered down to provide a maximum current consumption savings equivalent to the standby current provided in the *Current Consumption Characteristics* portion of *Electrical Characteristics*. The return to the output clock active time corresponds to the same as the initial start-up time.

The function pin is driven internally with resistance > 100kΩ.

8.3.4 Clock Output Interfacing and Termination

The following figure shows the recommended output interfacing and termination circuits.

**Figure 8-1. CDC6Cx Output to LVCMOS Receiver**

8.3.5 CDC6Cx CISPR25 Radiated Emission Performance

The CDC6Cx radiated EMI emissions performance passed up to CISPR-25 Class 5 for all bands except GPS L1 (1567.42MHz to 1583.42MHz) where the device passes Class 3. The CDC6Cx is configured for slow mode 2 with a 5pF termination. The test observed 1.8V and 3.3V, 25MHz CDC6Cx oscillators in the DLE and DLY packages. The boards used have 50mil trace lengths, and the boards are tested in Texas Instruments' pre-compliant EMI chamber set up for CISPR-25 with antennas operating up to 13GHz. For more information, refer to [CDC6Cx CISPR25 Radiated Emission Performance Report](#).

8.3.5.1 EMI Reduction and Slow Mode Options

For EMI reduction, the CDC6Cx has orderable options to reduce slew rate and increase rise and fall times. Slowing down the sharp rising and falling edges of a clock output, or lowering the output slew rate, decreases high-frequency harmonics, thereby lessening EMI. For applications requiring lesser EMI, select the appropriate rise and fall time options and see the [CDC6Cx CISPR25 Radiated Emission Performance Report](#) for more EMI reduction strategies.

The CDC6Cx has four slow mode options other than the normal mode. Based on the desired rise and fall times, select the right slow mode option and load capacitance value. [Table 8-2](#) shows the minimum recommended capacitance for each slow mode.

Table 8-2. Minimum Recommended Capacitance per Slow Mode

| SLOW MODE | MINIMUM RECOMMENDED CAPACITANCE (pF) |
|-------------|--------------------------------------|
| Slow Mode 1 | 2 |
| Slow Mode 2 | 5 |
| Slow Mode 3 | 10 |
| Slow Mode 4 | 15 |

[Table 8-3](#) has recommended slow mode options for various load capacitance for a 25MHz output clock. For example, with load capacitance 15pF, Slow Mode 4 option results in the slowest rise and fall times. You can also select Slow Mode 1, Slow Mode 2, or Slow Mode 3 with 15pF but the rise and fall times are faster.

Table 8-3. Rise / Fall Time Options (25MHz Output)

| SLOW MODE OPTION | LOAD CAPACITANCE | RISE AND FALL TIME (ns) WITH SLOW MODE (TYP / MAX) | RISE AND FALL TIME (ns) WITH NORMAL MODE (TYP / MAX) |
|------------------|------------------|--|--|
| Slow Mode 1 | 2pF | 0.81 / 1.06 | 0.62 / 1.01 |
| Slow Mode 2 | 5pF | 1.47 / 1.62 | 0.76 / 1.24 |
| Slow Mode 3 | 10pF | 2.44 / 2.61 | 1.4 / 1.7 |
| Slow Mode 4 | 15pF | 3.29 / 3.5 | 1.88 / 2.11 |

8.3.6 Temperature Stability

Figure 8-2 shows the CDC6Cx frequency change across temperature. The figure illustrates the frequency change of 80 different devices at different temperatures across the temperature range of -40°C to 105°C . This demonstrates the typical temperature stability of the device, remaining below $\pm 10\text{ppm}$.

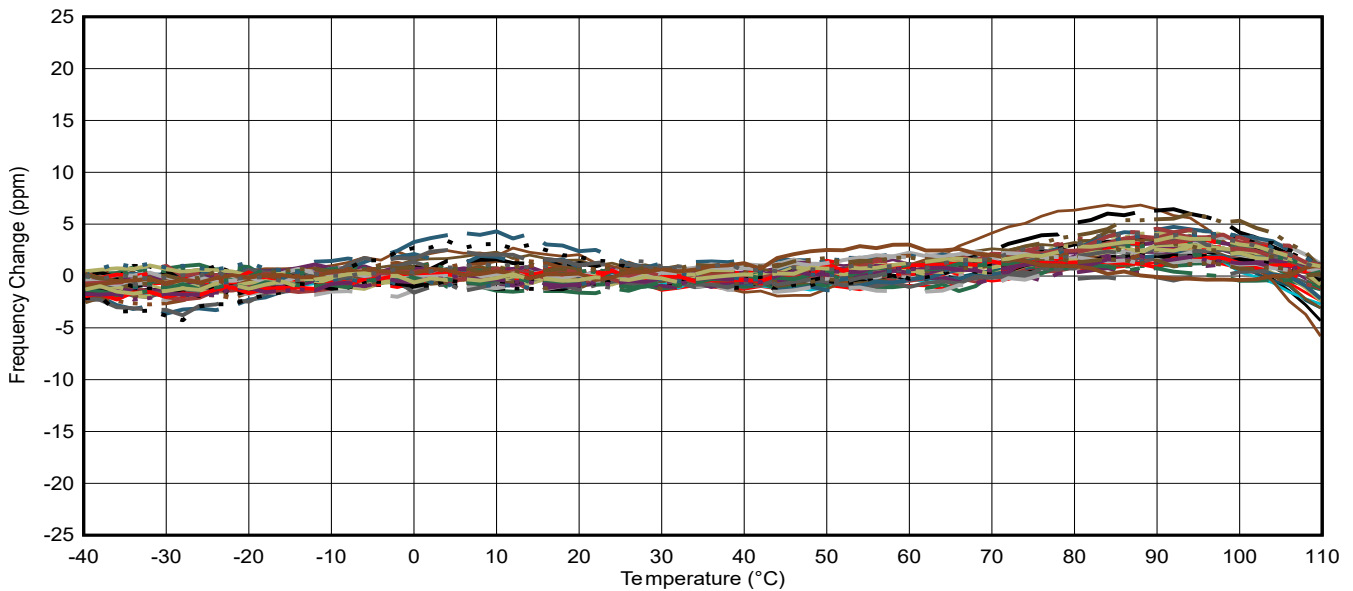


Figure 8-2. Typical Frequency Change From 25MHz Over Temperature Over 80 Devices

8.3.7 Frequency Aging

Table 8-4 shows the CDC6Cx typical frequency shift from aging at different temperatures. Frequency drift is measured over 1000 hours for each temperature and extrapolated using MIL-PRF-55310-REV-F to predict frequency stability for up to 20 years. After aging for 20 years at 75°C , the predicted frequency stability is $\pm 26\text{ppm}$.

Table 8-4. Typical Frequency Aging for the CDC6Cx at 55°C and 75°C through 20 Years

| TEMPERATURE ($^{\circ}\text{C}$) | 1-YEAR AGING (ppm) | | 10-YEAR AGING (ppm) | | 20-YEAR AGING (ppm) | |
|------------------------------------|----------------------------|---------------------------|----------------------------|---------------------------|----------------------------|---------------------------|
| | Frequency Drift from Aging | Total Frequency Stability | Frequency Drift from Aging | Total Frequency Stability | Frequency Drift from Aging | Total Frequency Stability |
| 55 | ± 2.39 | ± 21.43 | ± 3.41 | ± 22.62 | ± 3.72 | ± 23.5 |
| 75 | ± 2.58 | ± 21.96 | ± 3.92 | ± 24.6 | ± 4.33 | ± 25.33 |

8.3.8 Mechanical Robustness

For reference oscillators, vibration and shock are common causes for increased phase noise and jitter, frequency shift and spikes, or even physical damages to the resonator and package. Compared to quartz crystals, the BAW resonator is more immune to vibration and shock due to the orders of magnitude smaller mass and higher frequency—that is force applied to the device from acceleration is much smaller due to smaller mass.

Figure 8-3 shows the CDC6Cx BAW oscillator vibration performance. TI followed MIL-STD-883 Method 2026 Conditions C (10g) and Method 2007 Condition A (20g) for testing. In this test, the CDC6Cx oscillator is mounted on an EVM and subjected to a 10g acceleration force, ranging from 50Hz to 2kHz in the x, y, and z-axis. Phase noise trace with spur due to vibration is captured using Keysight E5052B and frequency deviation is calculated from the spur power. Then the frequency deviation is converted to ppb by noting the carrier frequency and normalized to ppb/g. Finally, the RMS sum of ppb/g along all three axes is reported as the Vibration sensitivity in ppb/g. CDC6Cx performance under vibration is approximately 2ppb/g while most quartz oscillators best case is 3ppb/g and worse can be above 10ppb/g.

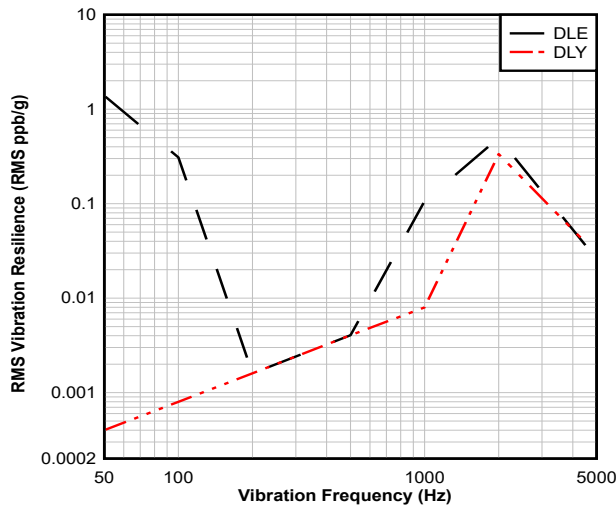


Figure 8-3. Vibration Resilience vs. Vibration Frequency at 25MHz, 25°C, Supply 1.8V - X-Axis

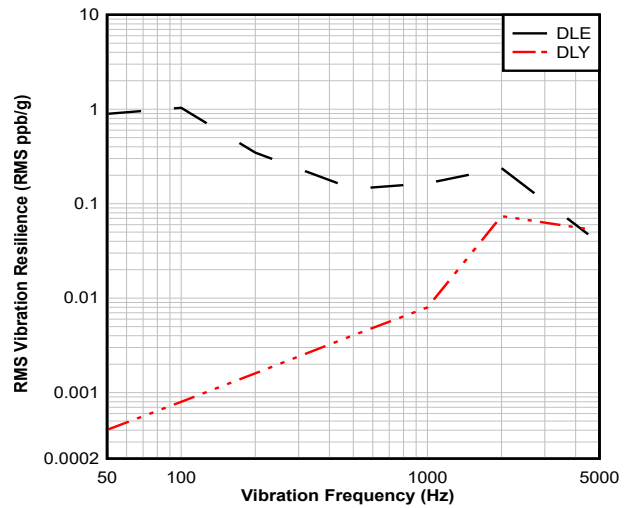


Figure 8-4. Vibration Resilience vs. Vibration Frequency at 25MHz, 25°C, Supply 1.8V - Y-Axis

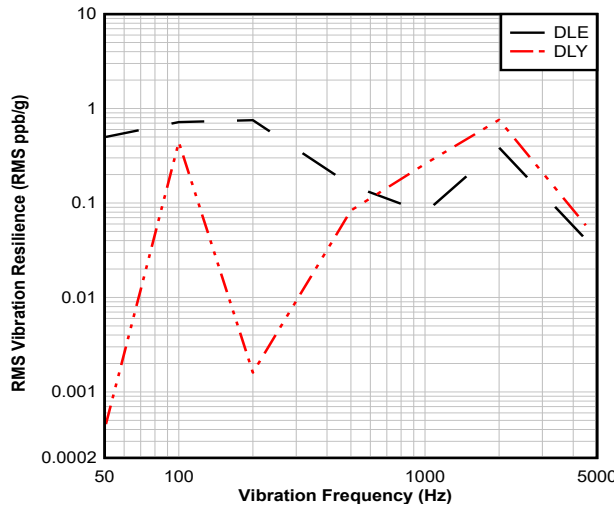


Figure 8-5. Vibration Resilience vs. Vibration Frequency at 25MHz, 25°C, Supply 1.8V - Z-Axis

For the mechanical shock test, TI followed MIL-STD-883F Method 2002 Condition A (1500g) for testing. For more information on BAW technology mechanical robustness, see the [Standalone BAW Oscillators Advantages Over Quartz Oscillators application note](#).

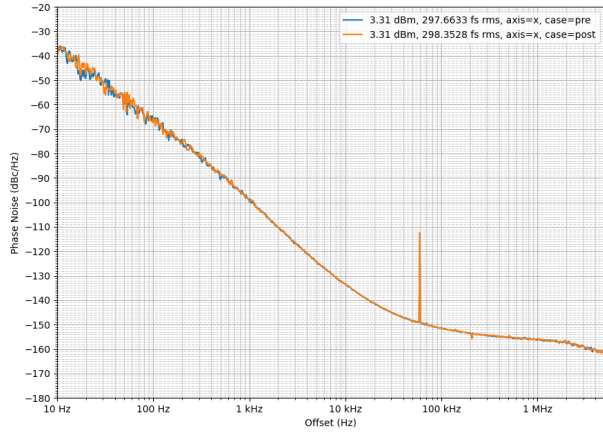


Figure 8-6. Pre and Post 1500g Mechanical Shock at 25MHz and 25°C, X-Axis

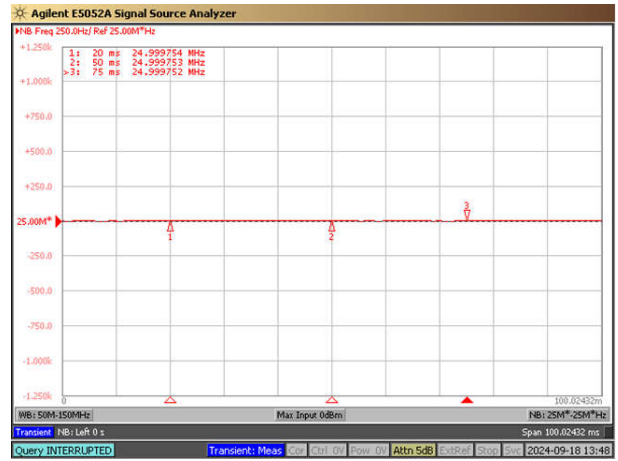


Figure 8-7. During 1500g Mechanical Shock at 25MHz and 25°C, X-Axis

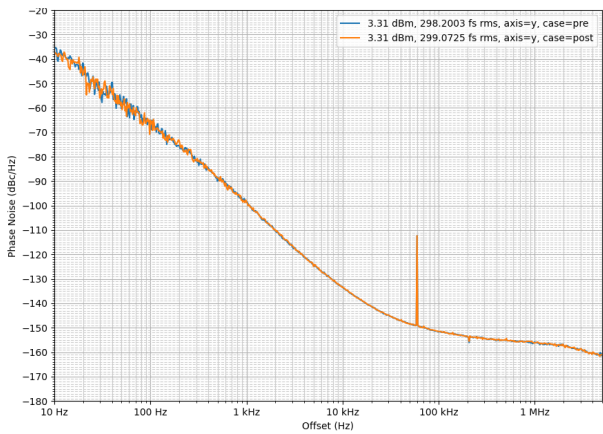


Figure 8-8. Pre and Post 1500g Mechanical Shock at 25MHz and 25°C, Y-Axis

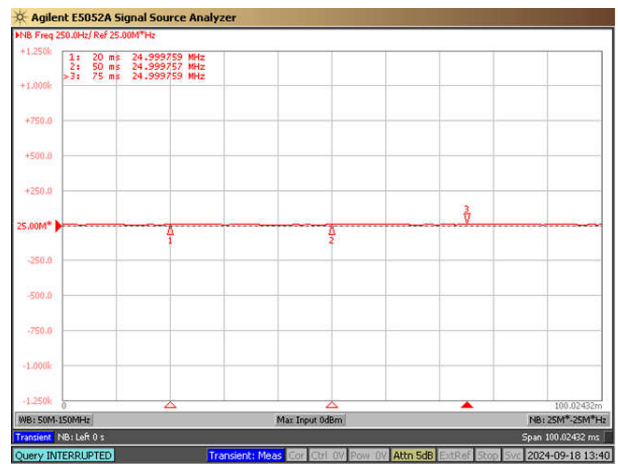


Figure 8-9. During 1500g Mechanical Shock at 25MHz and 25°C, Y-Axis

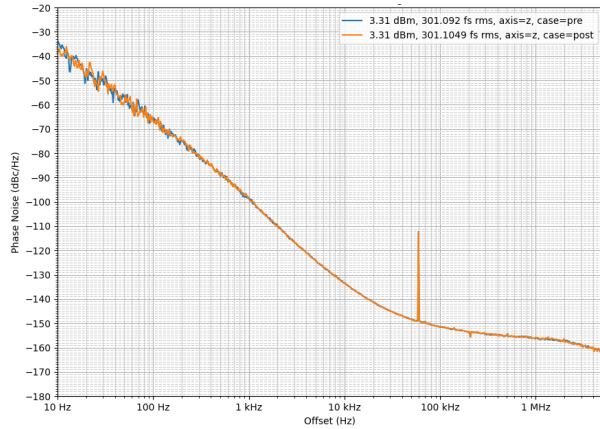


Figure 8-10. Pre and Post 1500g Mechanical Shock at 25MHz and 25°C, Z-Axis

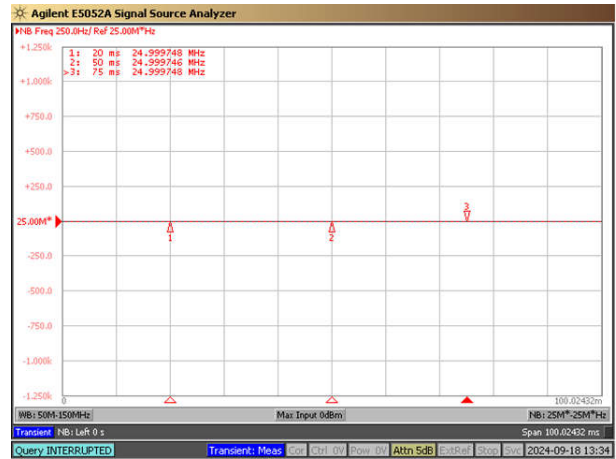


Figure 8-11. During 1500g Mechanical Shock at 25MHz and 25°C, Z-Axis

8.4 Device Functional Modes

The CDC6Cx BAW Oscillator is a fixed-frequency device and does not require any programming. The device pin 1 has different functions and the device can come pre-programmed with a specific clock output slew rate. See [Section 8.3.3](#) for more information on the function pins and [Section 8.3.5.1](#) for more information on the different slow modes.

9 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9.1 Application Information

The CDC6Cx is a low power, fixed-frequency oscillator that can be used as a reference clock. The device supports any output frequency between 250kHz to 200MHz, single-ended output type, and 1.8V to 3.3V supply rails.

9.1.1 Driving Multiple Loads With a Single CDC6Cx

The CDC6Cx oscillator can be used to drive multiple loads to achieve cost reduction and BOM simplification. Be aware that using this technique degrades signal integrity and decreases performance. A good set of guidelines to follow when driving multiple loads include aiming to drive only two loads, maximizing common trace lengths across loads, and limiting total receiver capacitance to maximize fast rise and fall times. For more information on the effects of this technique and an implementation guide, see the [Driving Multiple Loads With a Single LVCMOS Oscillator application note](#).

9.2 Typical Application

For a reference schematic implementation for CDC6Cx oscillator, see the [Layout Examples](#) for bypass capacitor and AC-coupling capacitor value recommendations. See the [Clock Output Interfacing and Termination](#) section for output clock required termination and biasing.

Figure 9-1 shows a typical application example. The CDC6Cx oscillator is used as a reference clock for a microcontroller or an FPGA in this example.

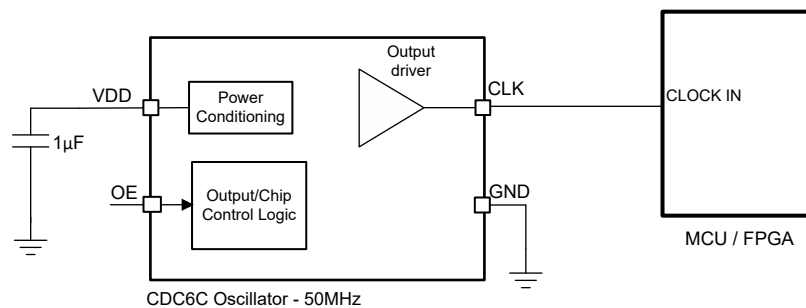


Figure 9-1. CDC6Cx Application Example

9.2.1 Design Requirements

The CDC6Cx is a fixed-frequency oscillator with no programming needed. Make sure to follow the recommended termination options as described in the [Clock Output Interfacing and Termination](#) section closely. See [Section 8.3.3](#) to understand pin 1 function, and order the part number as per your requirements for Output Enable (OE), or Standby (ST) options.

9.2.2 Detailed Design Procedure

The CDC6Cx has an integrated LDO and has excellent PSRR performance as shown in the [Electrical Characteristics](#) table. See the [CDC6CEVM User's Guide](#) for the reference layout recommendation while designing with the CDC6Cx BAW oscillator.

To set the pin 1 function for the CDC6Cx, connect typical 10k Ω or smaller resistor to VDD for driving the OE pin High. The device has an internal pullup resistor > 100k Ω , therefore this pin can be left open if an external pullup resistor is not desired. For driving the OE pin to Low, use the typical 10k Ω or smaller resistor as a pulldown resistor.

9.2.3 Application Curves

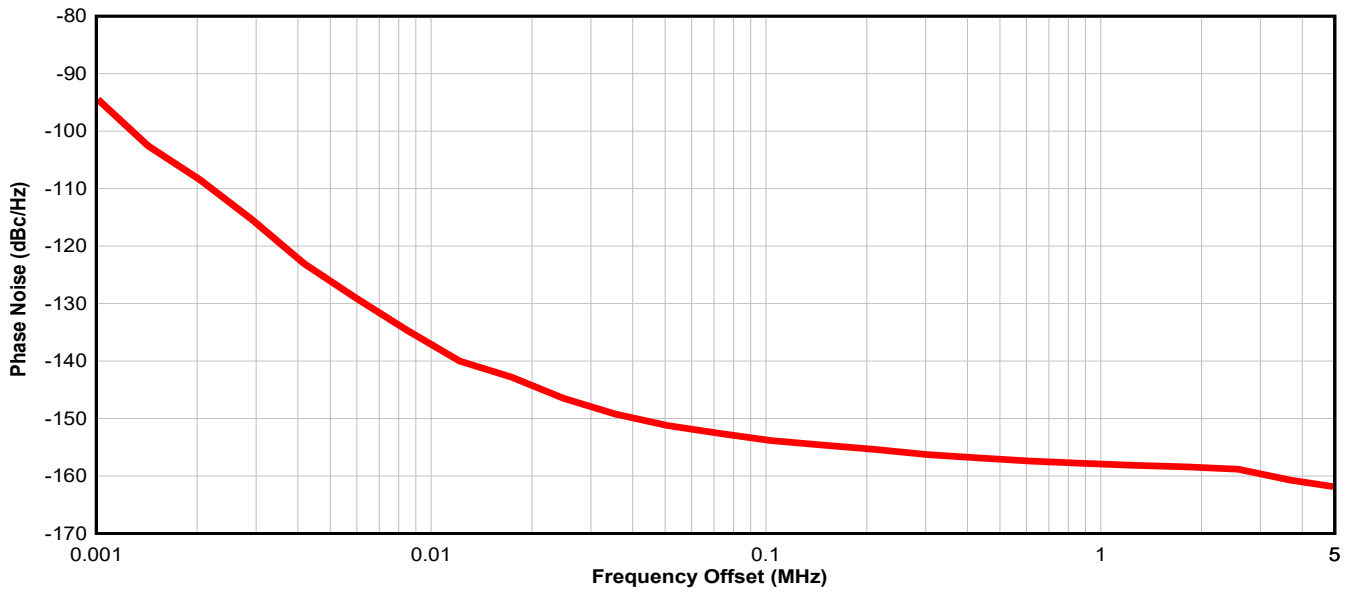


Figure 9-2. 19.2MHz LVC MOS, 25°C, 3.3V Supply

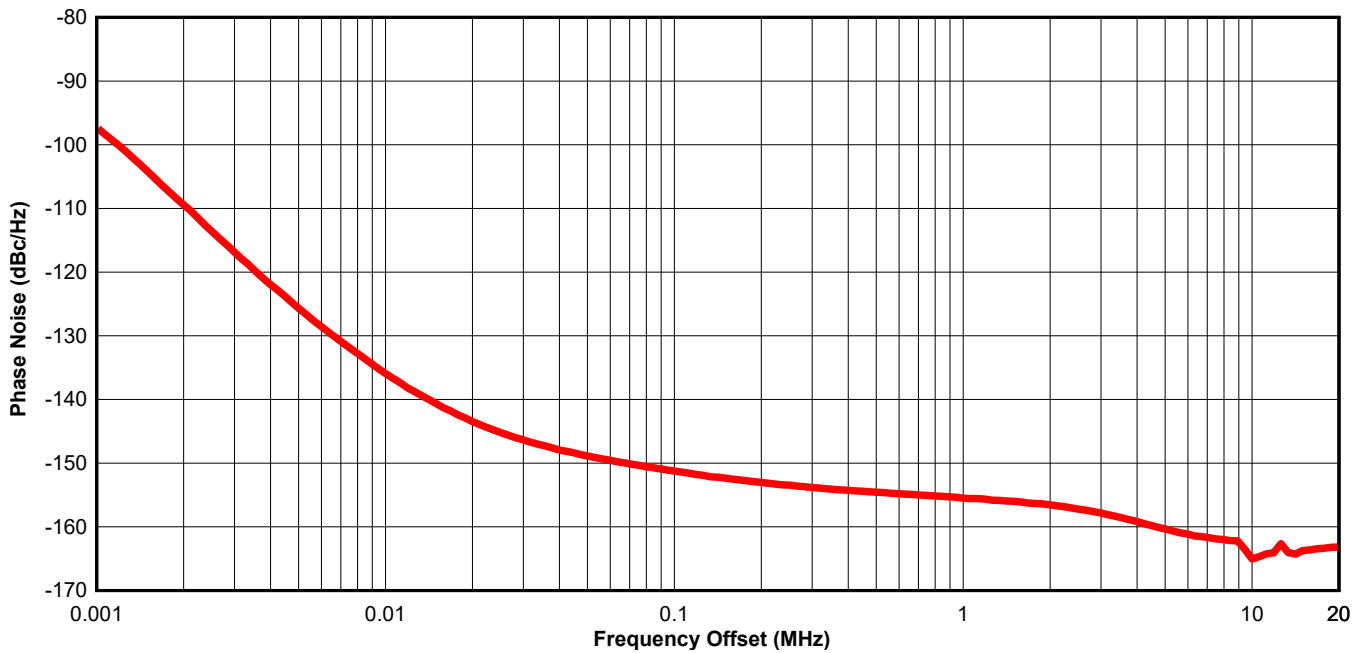


Figure 9-3. 25MHz LVC MOS, 25°C, 3.3V Supply

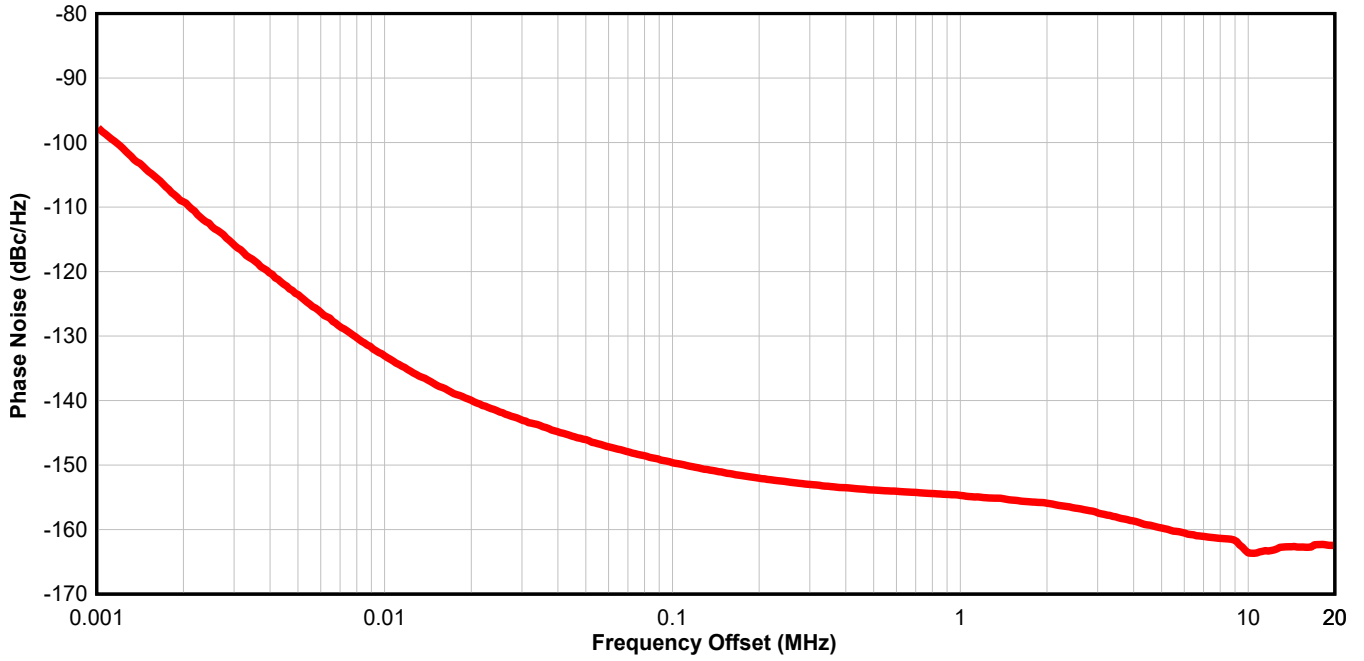


Figure 9-4. 27MHz LVC MOS, 25°C, 3.3V Supply

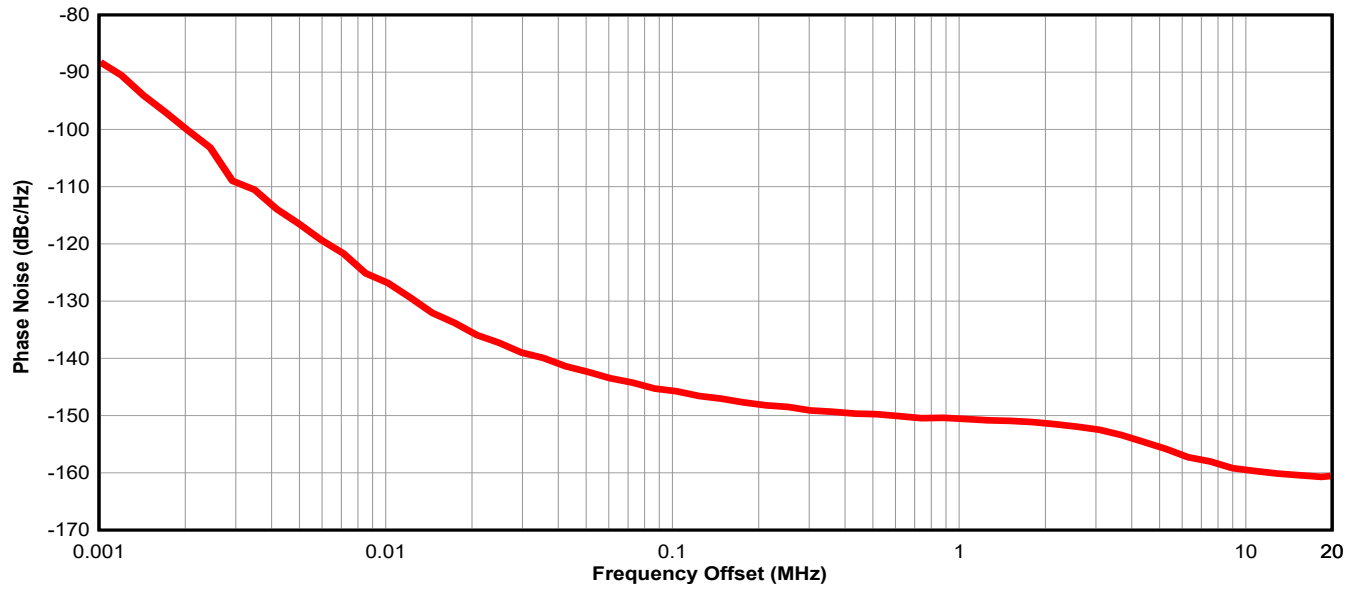


Figure 9-5. 50MHz LVC MOS, 25°C, 3.3V Supply

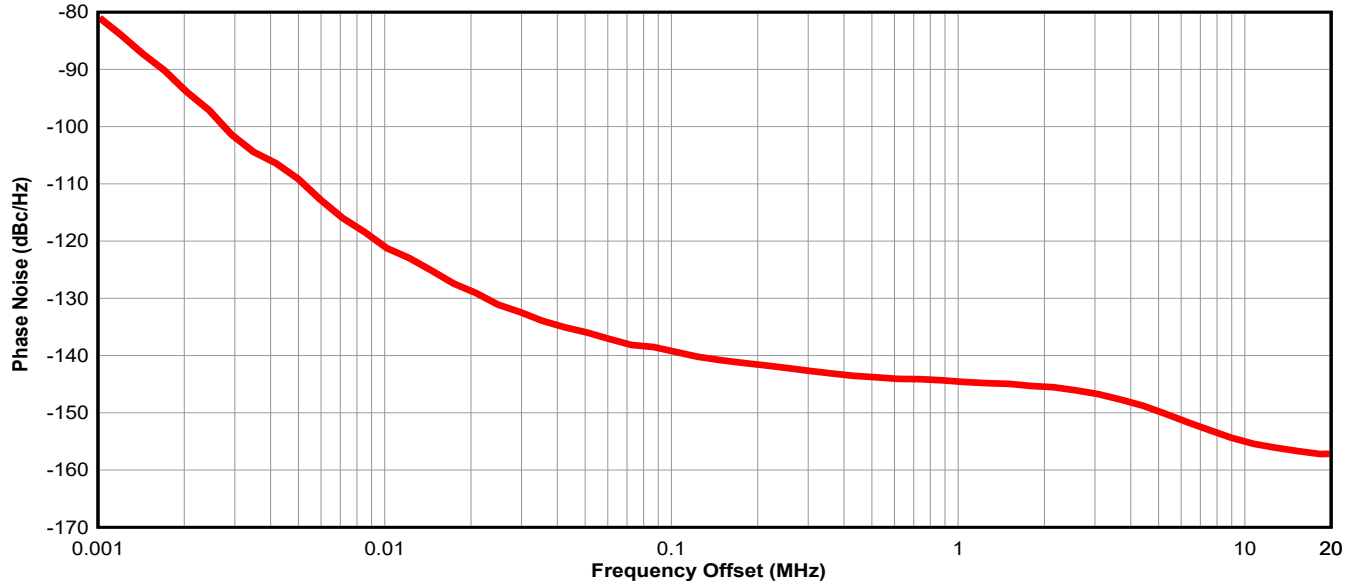


Figure 9-6. 100MHz LVCMOS, 25°C, 3.3V Supply

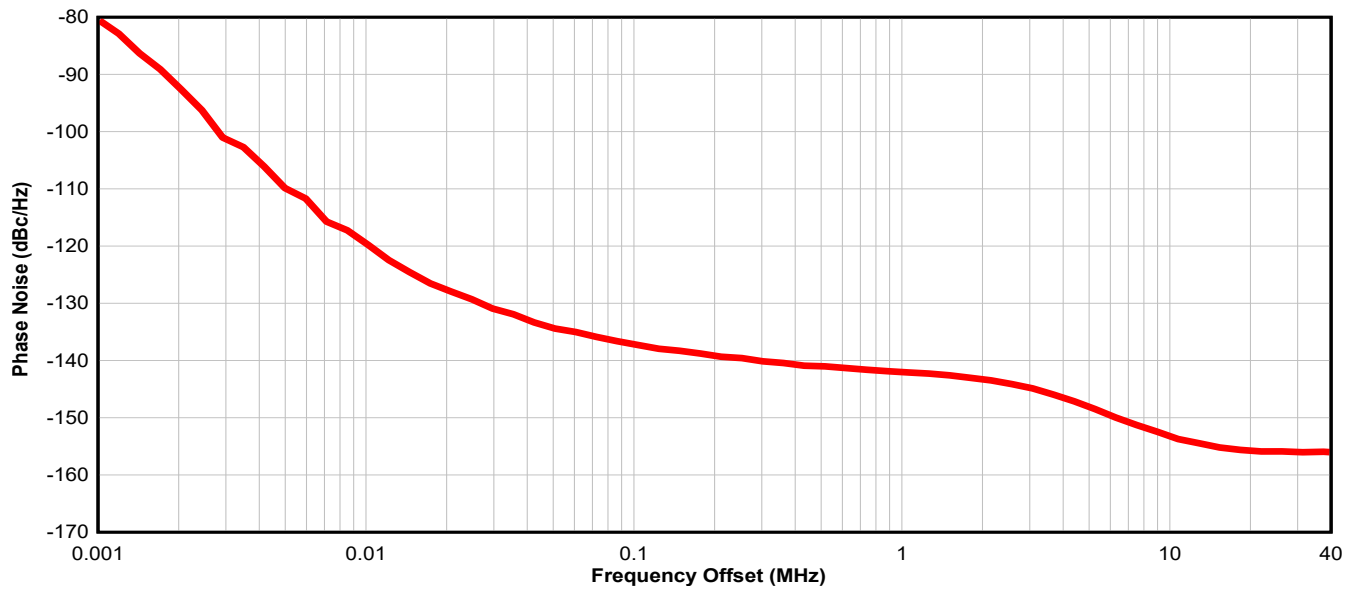


Figure 9-7. 125MHz LVCMOS, 25°C, 3.3V Supply

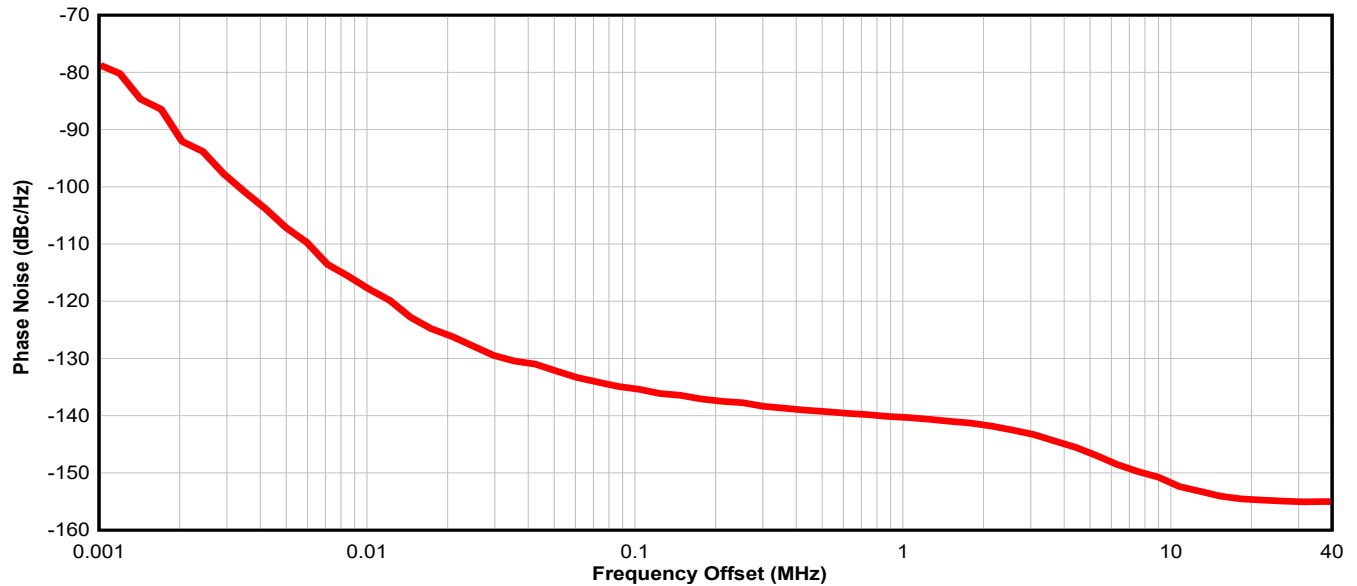


Figure 9-8. 156.25MHz LVCMOS, 25°C, 3.3V Supply

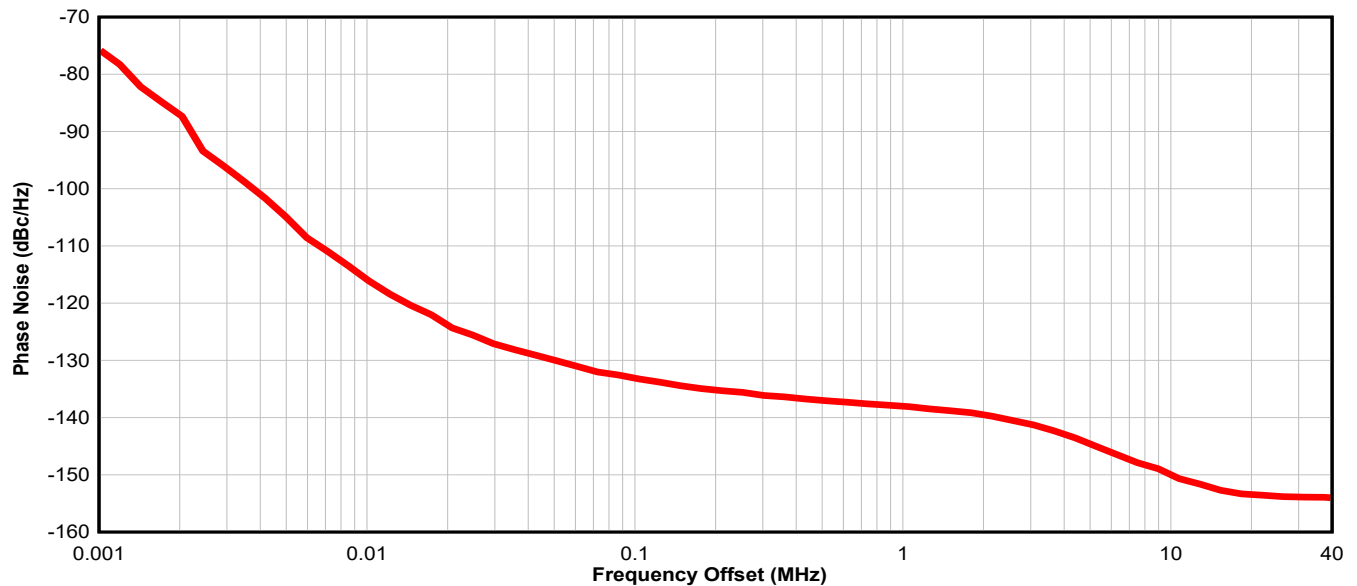


Figure 9-9. 200MHz LVCMOS, 25°C, 3.3V Supply

9.3 Power Supply Recommendations

For the best electrical performance of the CDC6Cx, TI recommends using a single 1 μ F power supply bypass capacitor. TI also recommends using component side mounting of the power supply bypass capacitors. 0201 or 0402 body size capacitors facilitate best signal routing. Keep the connections between the bypass capacitors and the power supply on the device as short as possible. Ground the other side of the capacitor using a low impedance connection to the ground plane.

V_{DD} power-up ramp time is defined as minimum time taken for power supply to exceed 95% of nominal V_{DD} . Monotonic power supply ramp is assumed. In case the power supply falls between 1V to 1.5V after the power supply already reached >1.5V, the output is muted after power supply ramps back to >1.5V. The output clock recovers, when V_{DD} is lowered below 1V and ramped back to >1.5V.

9.4 Layout

9.4.1 Layout Guidelines

The following sections provides recommendations for board layout, solder reflow profile and power-supply bypassing when using the CDC6Cx to provide good thermal and electrical performance and signal integrity of the entire system.

9.4.1.1 Providing Thermal Reliability

The CDC6Cx is a low power, high performance device. Therefore, pay careful attention to device configuration and printed circuit board (PCB) layout with respect to power consumption. The ground pin must be connected to the ground plane of the PCB through three vias or more to maximize thermal dissipation out of the package.

The equation below describes the relationship between the PCB temperature around the CDC6Cx and the junction temperature.

$$T_B = T_J - \Psi_{JB} \times P \quad (1)$$

where

- T_B : PCB temperature around the CDC6Cx
- T_J : Junction temperature of CDC6Cx
- Ψ_{JB} : Junction-to-board thermal resistance parameter of CDC6Cx (refer to the *Thermal Information* tables in the [Specifications](#) section for this information)
- P: On-chip power dissipation of CDC6Cx

9.4.1.2 Recommended Solder Reflow Profile

TI recommends following the recommendations from the solder paste supplier to optimize flux activity and to achieve proper melting temperatures of the alloy within the guidelines of J-STD-020E. Processing the CDC6Cx with the lowest peak temperature possible while also remaining below the components peak temperature rating as listed on the MSL label is preferable. The exact temperature profile depends on several factors including maximum peak temperature for the component as rated on the MSL label, Board thickness, PCB material type, PCB geometries, component locations, sizes, densities within PCB, solder manufactures recommended profile, and capability of the reflow equipment as confirmed by the SMT assembly operation.

9.4.2 Layout Examples

Figure 9-10 shows the printed circuit board (PCB) layout examples as done on the evaluation module (EVM) for the CDC6Cx.

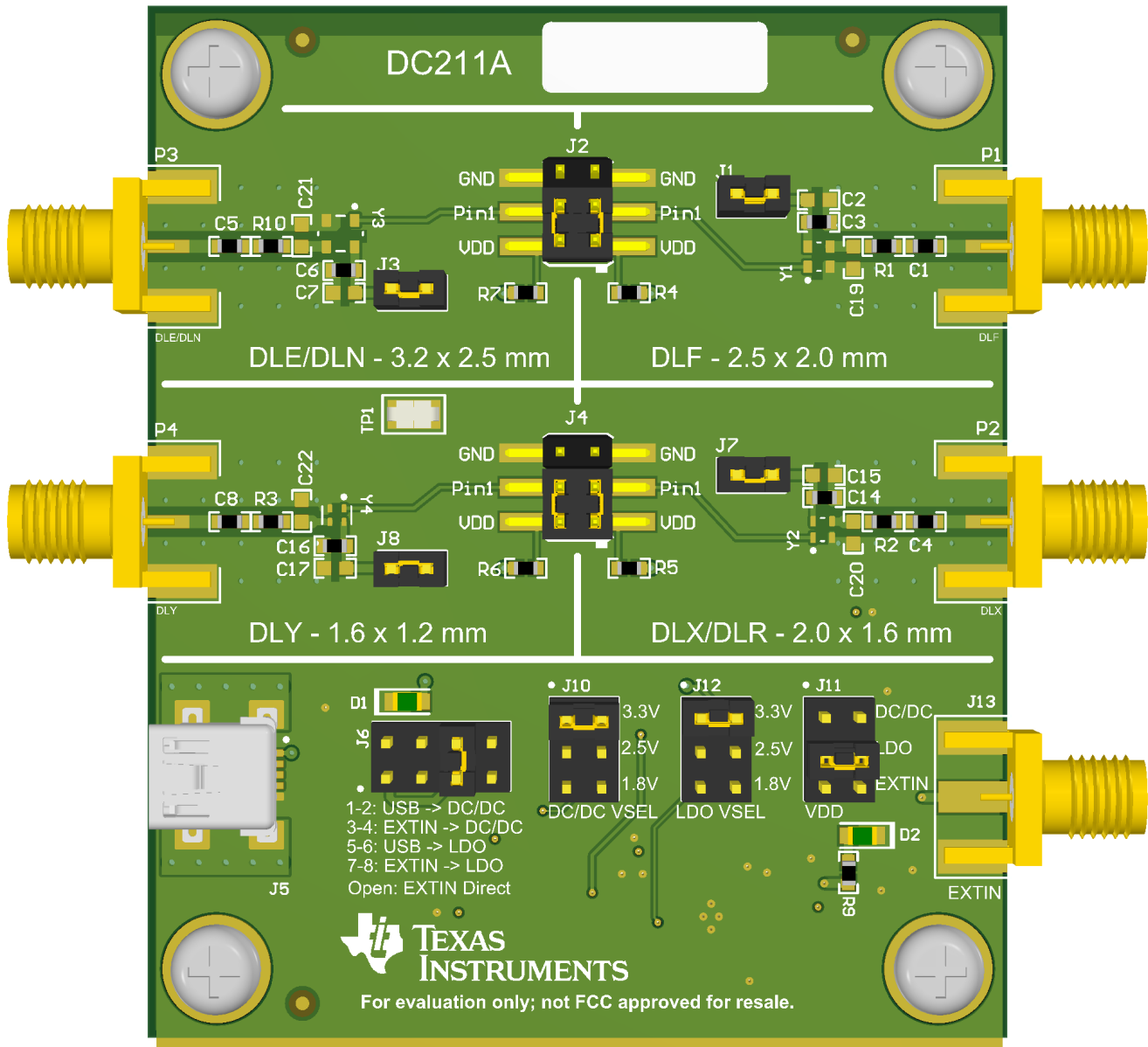


Figure 9-10. PCB Layout Example From CDC6 EVM

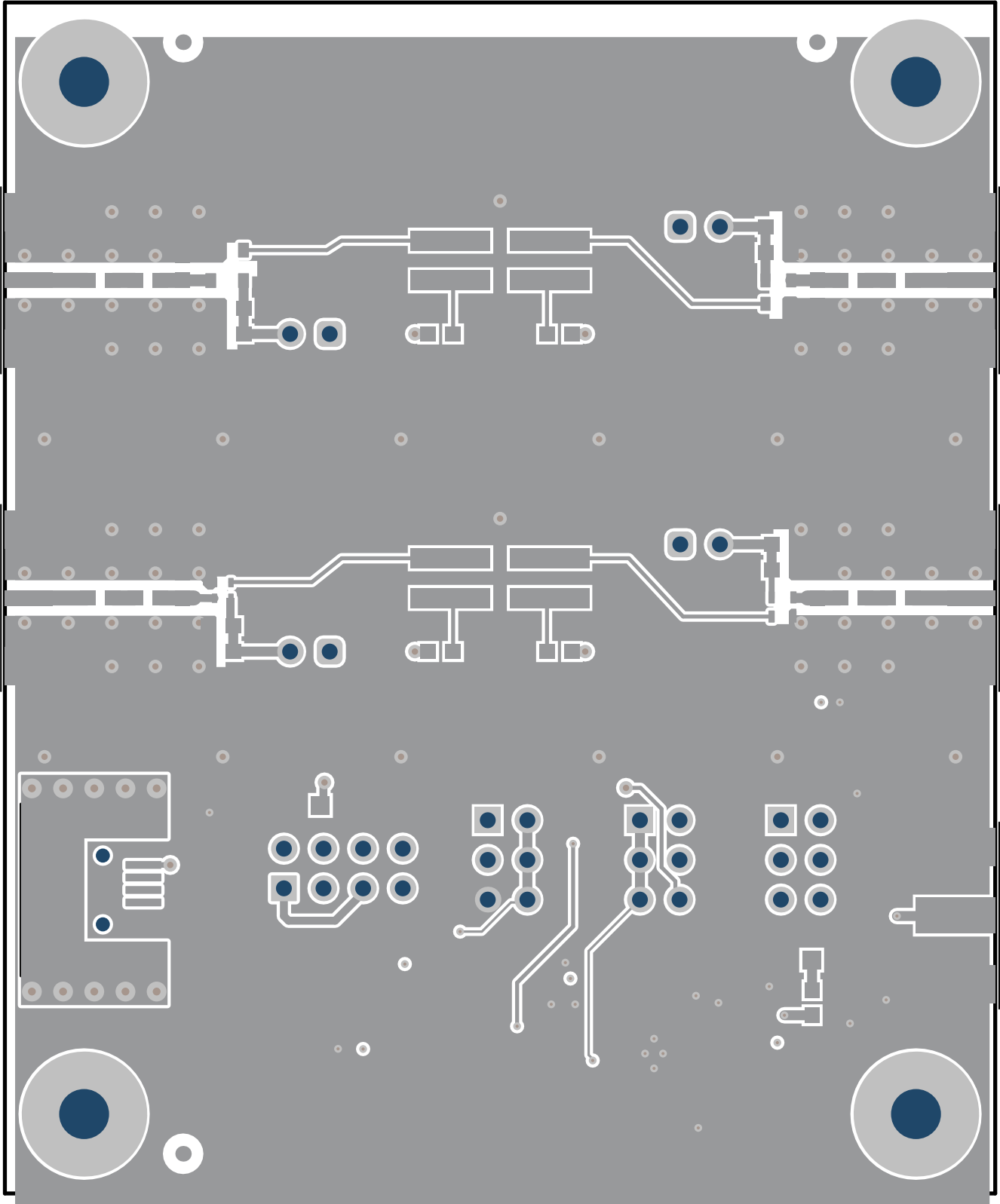


Figure 9-11. PCB Layout Example From CDC6 EVM - Top Layer

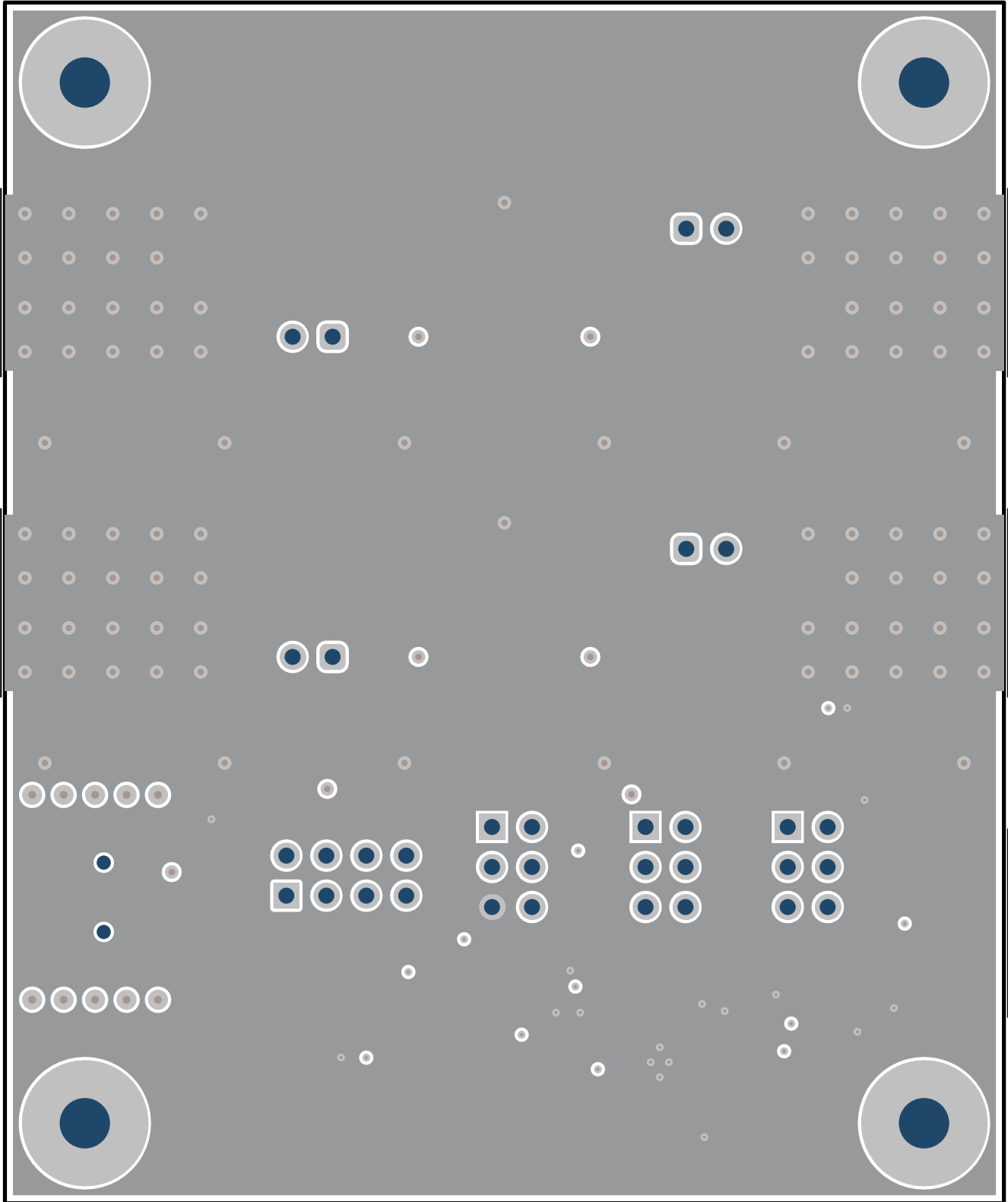


Figure 9-12. PCB Layout Example From CDC6 EVM - GND Layer

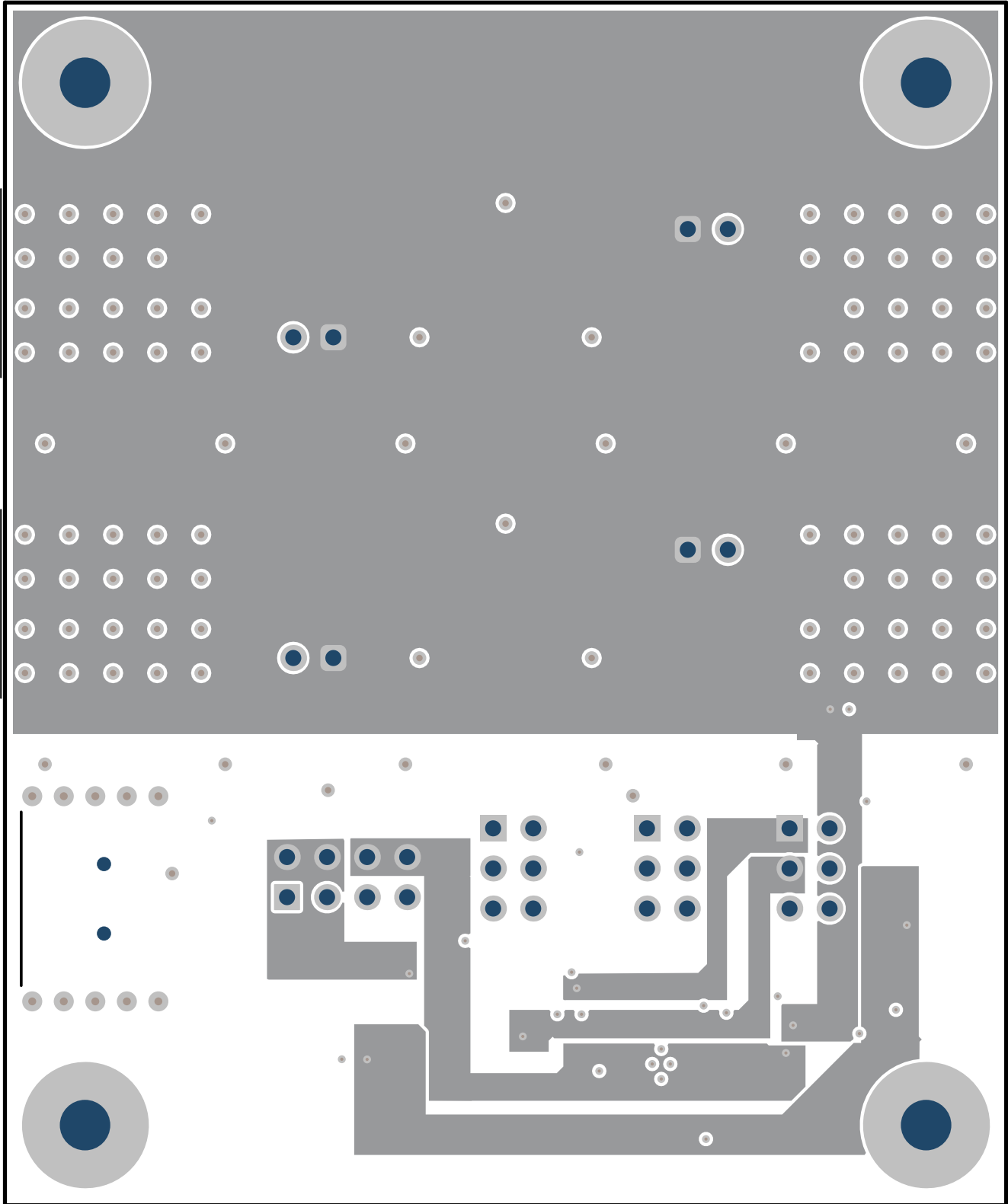


Figure 9-13. PCB Layout Example From CDC6 EVM - Power Layer

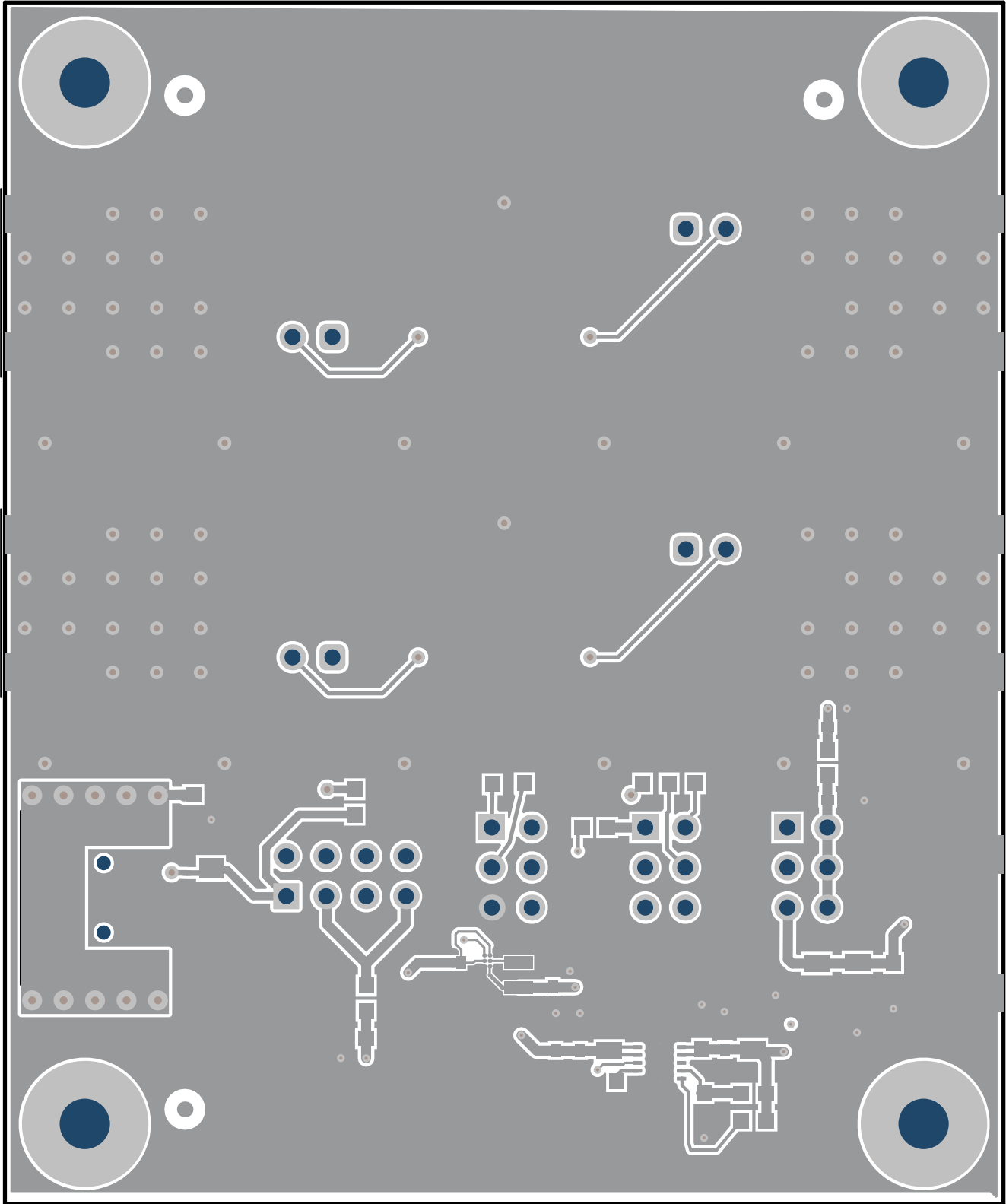


Figure 9-14. PCB Layout Example From CDC6 EVM - Bottom Layer

10 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop designs are listed below.

10.1 Documentation Support

10.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, [CDC6CEVM User's Guide](#)
- Texas Instruments, [CDC6C OPN Decoder application note](#)
- Texas Instruments, [CDC6C-Q1 Functional Safety FIT Rate, FMD and Pin FMA](#)
- Texas Instruments, [Standalone BAW Oscillators Advantages Over Quartz Oscillators application note](#)
- Texas Instruments, [Driving Multiple Loads With a Single LVCMOS Oscillator application note](#)
- Texas Instruments, [CDC6Cx-Q1 CISPR25 Radiated Emission Performance Report](#)
- Texas Instruments, [BAW Oscillator Designs for Building Automation application note](#)
- Texas Instruments, [BAW Oscillator Designs for Factory Automation application note](#)
- Texas Instruments, [BAW Oscillator Designs for Grid Infrastructure application note](#)
- Texas Instruments, [BAW Oscillator Designs for Optical Modules application note](#)

10.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

10.3 Support Resources

TI E2E™ [support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

10.4 Trademarks

TI E2E™ is a trademark of Texas Instruments.
All trademarks are the property of their respective owners.

10.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

10.6 Glossary

[TI Glossary](#) This glossary lists and explains terms, acronyms, and definitions.

11 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision C (July 2025) to Revision D (January 2026) | Page |
|--|------|
| • Added corrections to specifications on the first page to match specifications table and added comment about universal land patterns..... | 1 |
| • Added reference to <i>EMI Reduction and Slow Mode Options</i> to explain slow mode orderable options..... | 3 |
| • Added minimum storage temperature..... | 5 |

| | |
|---|----|
| • Added 10% to 90% rise and fall time typical values..... | 6 |
| • Removed minimum and maximum values for output impedance..... | 6 |
| • Updated input current based on designs recent findings..... | 6 |
| • Changed standby and output enable specs for clarity and added spec for $\leq 100\text{MHz}$ | 6 |
| • Added diagram to describe standby and output enable pin power-on characteristics..... | 9 |
| • Changed the order of HIGH and LOW functions for structural consistency..... | 15 |
| • Created EMI reduction information and moved information from the <i>Detailed Design Procedure</i> | 16 |
| • Emphasizing capacitor used for slow mode options is minimum recommended value..... | 16 |
| • Added Section 8.3.7 | 17 |
| • Added reference to Section 8.3.5.1 | 20 |

| Changes from Revision B (May 2025) to Revision C (July 2025) | Page |
|---|-------------|
| • Specified frequency stability for each package size..... | 1 |
| • Specified available frequency stability orderable options per package size..... | 1 |
| • Specified improved frequency stability for DLE, DLF, and DLX packages..... | 15 |

| Changes from Revision A (January 2025) to Revision B (May 2025) | Page |
|---|-------------|
| • Updated the numbering formatting for tables, figures, and cross-references throughout the document..... | 1 |
| • Added legend to explain color assignment for the <i>Pin Functions</i> table..... | 4 |
| • Added output frequency used for all output rise and fall time data..... | 6 |
| • Added frequency stability for -40°C to 85°C temperature range..... | 6 |
| • Combined random phase jitter to show jitter values based on output frequency range rather than specific output frequencies..... | 6 |
| • Changed 25MHz output to include random phase jitter from 12kHz to 20MHz offsets..... | 6 |
| • Removed integration bandwidth for RMS period jitter..... | 6 |
| • Updated Figure 6-10 to include frequency offsets through 20MHz..... | 11 |
| • Updated the <i>Detailed Design Procedure</i> to specify output frequency of 25MHz and corrected rise and fall times to match the <i>Electrical Characteristics</i> table..... | 21 |
| • Changed Figure 9-3 and Figure 9-4 to include frequency offsets through 20MHz..... | 23 |
| • Updated the Mechanical, Packaging, and Orderable Information section..... | 36 |

| Changes from Revision * (December 2024) to Revision A (January 2025) | Page |
|--|-------------|
| • Updated the numbering formatting for tables, figures, and cross-references throughout the document..... | 1 |
| • Moved Section 8.3.5 and Section 8.3.5.1 to separate, independent sections under the <i>Feature Description</i> | 16 |
| • Removed V _{DD} power-up ramp time requirements, no specific power-up requirements are no longer needed | 26 |

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CDC6CA005120ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | DB |
| CDC6CA008000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HB |
| CDC6CA008000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HB |
| CDC6CA008192ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | IB |
| CDC6CA025000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AB |
| CDC6CA025000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AB |
| CDC6CA025000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 8A |
| CDC6CA050000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | KB |
| CDC6CA050000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | KB |
| CDC6CE001000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | WB |
| CDC6CE007056ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GB |
| CDC6CE007680ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | FB |
| CDC6CE008000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | TA |
| CDC6CE008000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | TA |
| CDC6CE008000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | TA |
| CDC6CE008000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | TA |
| CDC6CE008000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | LB |
| CDC6CE008192ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | MA |
| CDC6CE008192ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | MA |
| CDC6CE008192ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | MA |
| CDC6CE008192ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | MA |
| CDC6CE010000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | UA |
| CDC6CE012000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 1A |
| CDC6CE012000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 1A |
| CDC6CE012288ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | FA |
| CDC6CE012288ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | FA |
| CDC6CE012288ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | FA |
| CDC6CE012288ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | FA |
| CDC6CE016000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | BA |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CDC6CE019200ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | IA |
| CDC6CE019200ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | IA |
| CDC6CE019200ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | IA |
| CDC6CE019200ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | IA |
| CDC6CE019200EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 5A |
| CDC6CE020000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | EA |
| CDC6CE020000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | EA |
| CDC6CE020000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | EA |
| CDC6CE020000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | EA |
| CDC6CE024000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | DA |
| CDC6CE024000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | DA |
| CDC6CE024000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | DA |
| CDC6CE024000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | DA |
| CDC6CE024000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 7A |
| CDC6CE024576ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | BB |
| CDC6CE025000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLER.A | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLFR.A | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000ADLYR.A | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | AA |
| CDC6CE025000CDLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | OB |
| CDC6CE025000EDLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 4A |
| CDC6CE025000EDLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 4A |
| CDC6CE025000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 4A |
| CDC6CE026000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | XB |
| CDC6CE026000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | XB |
| CDC6CE026000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 6A |
| CDC6CE027000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | JA |
| CDC6CE027000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | JA |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-------------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CDC6CE027000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 105 | JA |
| CDC6CE027000ADLXR.A | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 105 | JA |
| CDC6CE027000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | JA |
| CDC6CE032768ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | VB |
| CDC6CE032768ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | VB |
| CDC6CE033333ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HA |
| CDC6CE033333ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HA |
| CDC6CE033333ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HA |
| CDC6CE033333ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | HA |
| CDC6CE036000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | QB |
| CDC6CE038400EDLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | NB |
| CDC6CE040000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GA |
| CDC6CE040000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GA |
| CDC6CE040000ADLFR.A | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GA |
| CDC6CE040000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GA |
| CDC6CE040000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | GA |
| CDC6CE040000EDLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | JB |
| CDC6CE043500EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 3A |
| CDC6CE048000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | KA |
| CDC6CE048000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | KA |
| CDC6CE048000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | KA |
| CDC6CE048000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | - | Call TI | Level-1-260C-UNLIM | -40 to 105 | KA |
| CDC6CE050000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | CA |
| CDC6CE050000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | CA |
| CDC6CE050000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | CA |
| CDC6CE050000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | CA |
| CDC6CE050000EDLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | 2A |
| CDC6CE066660ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | VA |
| CDC6CE100000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | LA |
| CDC6CE100000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | LA |
| CDC6CE125000ADLER | Active | Production | VSON (DLE) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | OA |

| Orderable part number | Status (1) | Material type (2) | Package Pins | Package qty Carrier | RoHS (3) | Lead finish/ Ball material (4) | MSL rating/ Peak reflow (5) | Op temp (°C) | Part marking (6) |
|-----------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| CDC6CE125000ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | OA |
| CDC6CE125000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | OA |
| CDC6CE125000ADLYR | Active | Production | VSON (DLY) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | OA |
| CDC6CE156250ADLFR | Active | Production | VSON (DLF) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | NA |
| CDC6CE156250ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | NA |
| CDC6CE200000ADLXR | Active | Production | VSON (DLX) 4 | 3000 LARGE T&R | Yes | Call TI | Level-1-260C-UNLIM | -40 to 105 | WA |

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

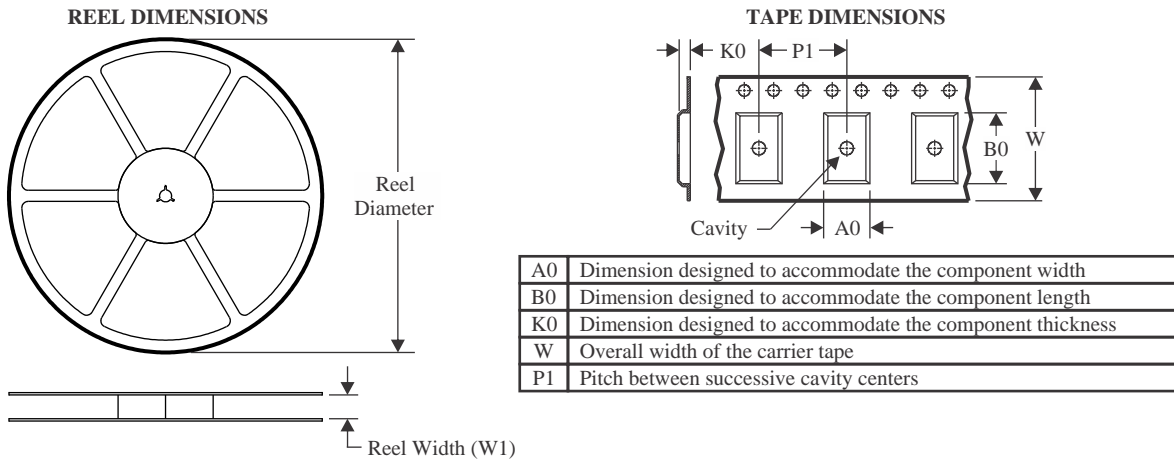
OTHER QUALIFIED VERSIONS OF CDC6C :

- Automotive : [CDC6C-Q1](#)

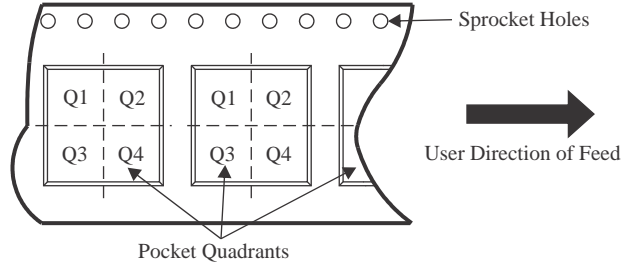
NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC6CA005120ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CA008000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CA008000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CA008192ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CA025000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CA025000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CA025000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CA050000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CA050000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE001000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE007056ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE007680ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE008000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE008000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE008000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE008000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC6CE008000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE008192ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE008192ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE008192ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE008192ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE010000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE012000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE012000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE012288ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE012288ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE012288ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE012288ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE016000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE019200ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE019200ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE019200ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE019200ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE019200EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE020000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE020000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE020000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE020000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE024000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE024000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE024000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE024000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE024000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE024576ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE025000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE025000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE025000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE025000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE025000CDLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE025000EDLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE025000EDLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE025000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE026000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE026000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE026000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE027000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE027000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| CDC6CE027000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE027000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE032768ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE032768ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE033333ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE033333ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE033333ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE033333ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE036000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE038400EDLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE040000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE040000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE040000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE040000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE040000EDLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE043500EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE048000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE048000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE048000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE048000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE050000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE050000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE050000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE050000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE050000EDLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE066660ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE100000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE100000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE125000ADLER | VSON | DLE | 4 | 3000 | 330.0 | 12.4 | 2.8 | 3.5 | 1.2 | 4.0 | 12.0 | Q1 |
| CDC6CE125000ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE125000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE125000ADLYR | VSON | DLY | 4 | 3000 | 180.0 | 8.4 | 1.45 | 1.9 | 1.07 | 4.0 | 8.0 | Q1 |
| CDC6CE156250ADLFR | VSON | DLF | 4 | 3000 | 180.0 | 8.4 | 2.25 | 2.8 | 1.1 | 4.0 | 8.0 | Q1 |
| CDC6CE156250ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |
| CDC6CE200000ADLXR | VSON | DLX | 4 | 3000 | 180.0 | 8.4 | 1.85 | 2.3 | 1.16 | 4.0 | 8.0 | Q1 |

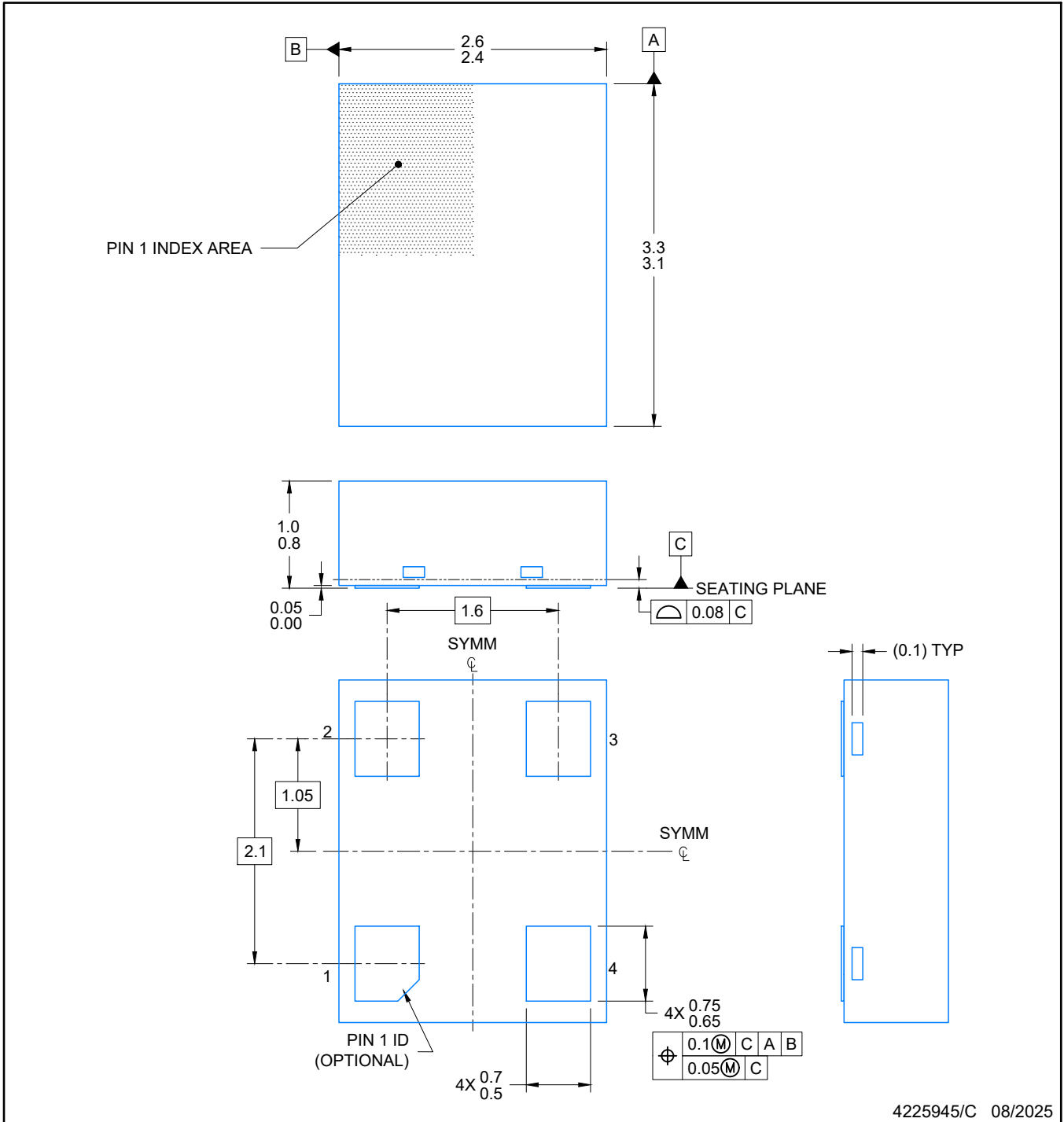
TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC6CA005120ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA008000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA008000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA008192ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA025000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CA025000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA025000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CA050000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CA050000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE001000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE007056ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE007680ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE008000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008192ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC6CE008192ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008192ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE008192ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE010000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE012000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE012000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE012288ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE012288ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE012288ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE012288ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE016000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE019200ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE019200ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE019200ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE019200ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE019200EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE020000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE020000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE020000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE020000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE024000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE024000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE024000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE024000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE024000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE024576ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE025000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000CDLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000EDLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE025000EDLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE025000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE026000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE026000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE026000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE027000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE027000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE027000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE027000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE032768ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE032768ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CDC6CE033333ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE033333ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE033333ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE033333ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE036000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE038400EDLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE040000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE040000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE040000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE040000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE040000EDLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE043500EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE048000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE048000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE048000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE048000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE050000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE050000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE050000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE050000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE050000EDLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE066660ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE100000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE100000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE125000ADLER | VSON | DLE | 4 | 3000 | 367.0 | 367.0 | 35.0 |
| CDC6CE125000ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE125000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE125000ADLYR | VSON | DLY | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE156250ADLFR | VSON | DLF | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE156250ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |
| CDC6CE200000ADLXR | VSON | DLX | 4 | 3000 | 182.0 | 182.0 | 20.0 |



4225945/C 08/2025

NOTES:

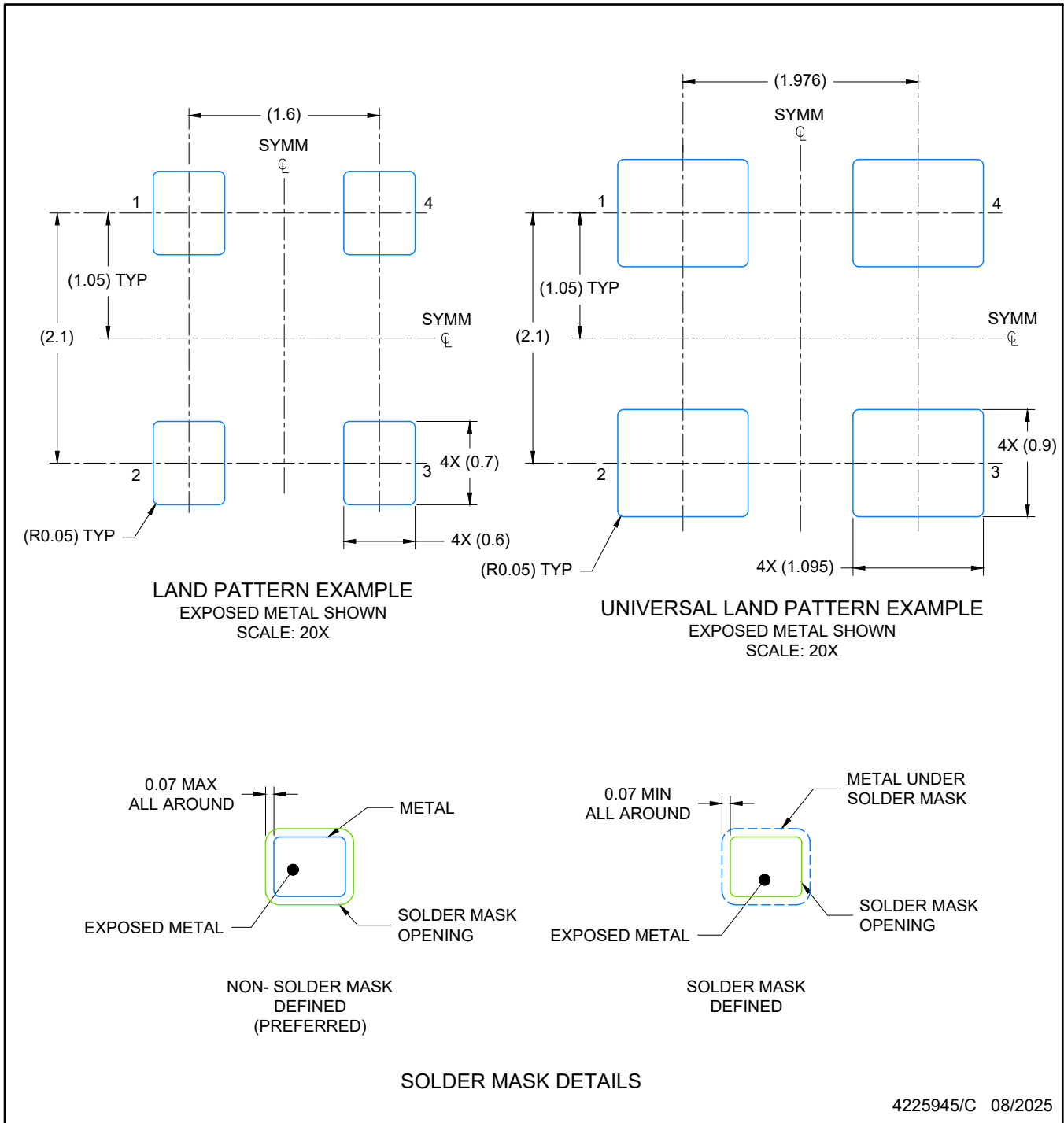
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

VSON - 1 mm max height

DLE0004A

PLASTIC QUAD FLAT PACK-NO LEAD



NOTES: (continued)

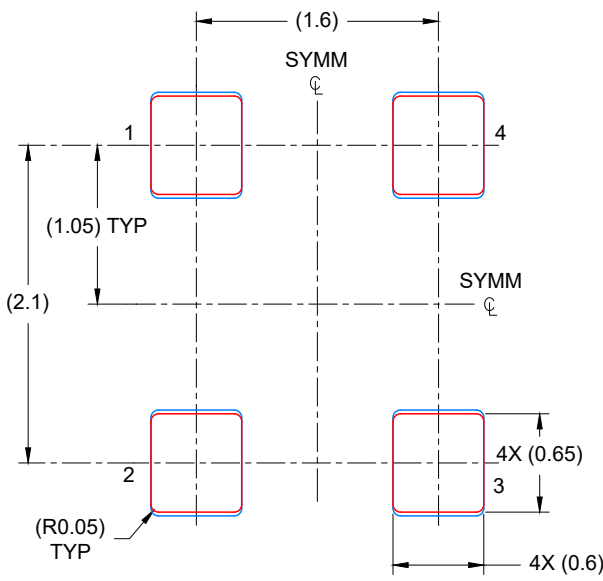
- For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271).

EXAMPLE STENCIL DESIGN

VSON - 1 mm max height

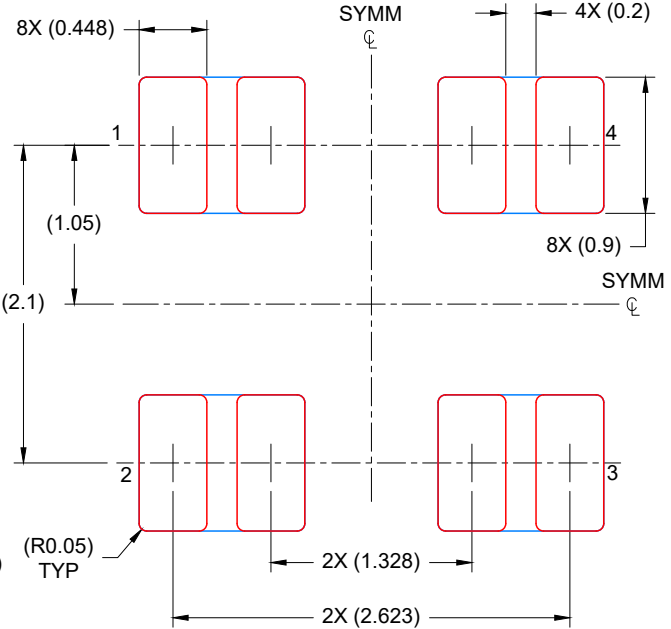
DLE0004A

PLASTIC QUAD FLAT PACK-NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
ALL PADS: 93%
SCALE: 20X



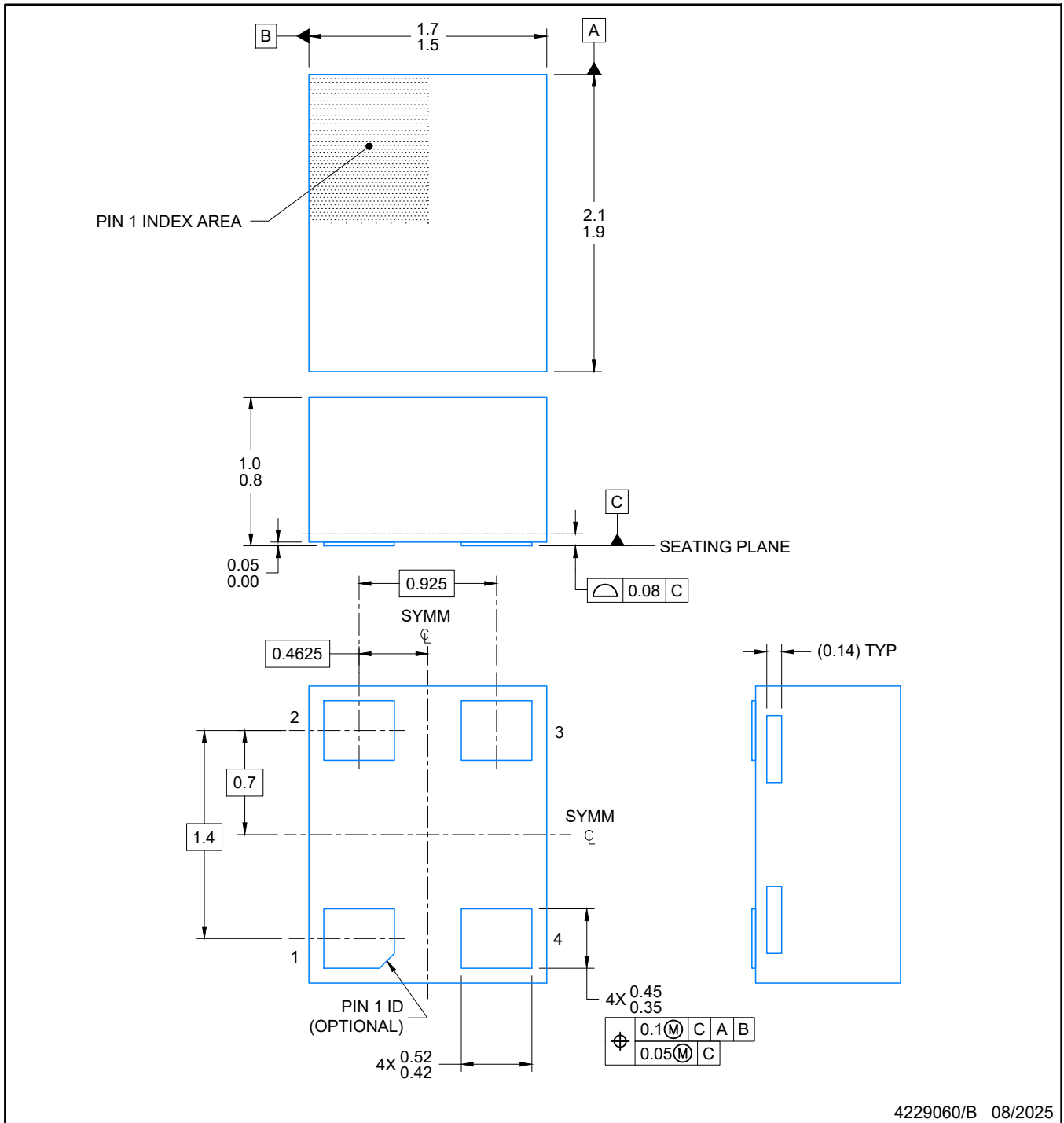
UNIVERSAL SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
ALL PADS: 82%
SCALE: 20X

4225945/C 08/2025

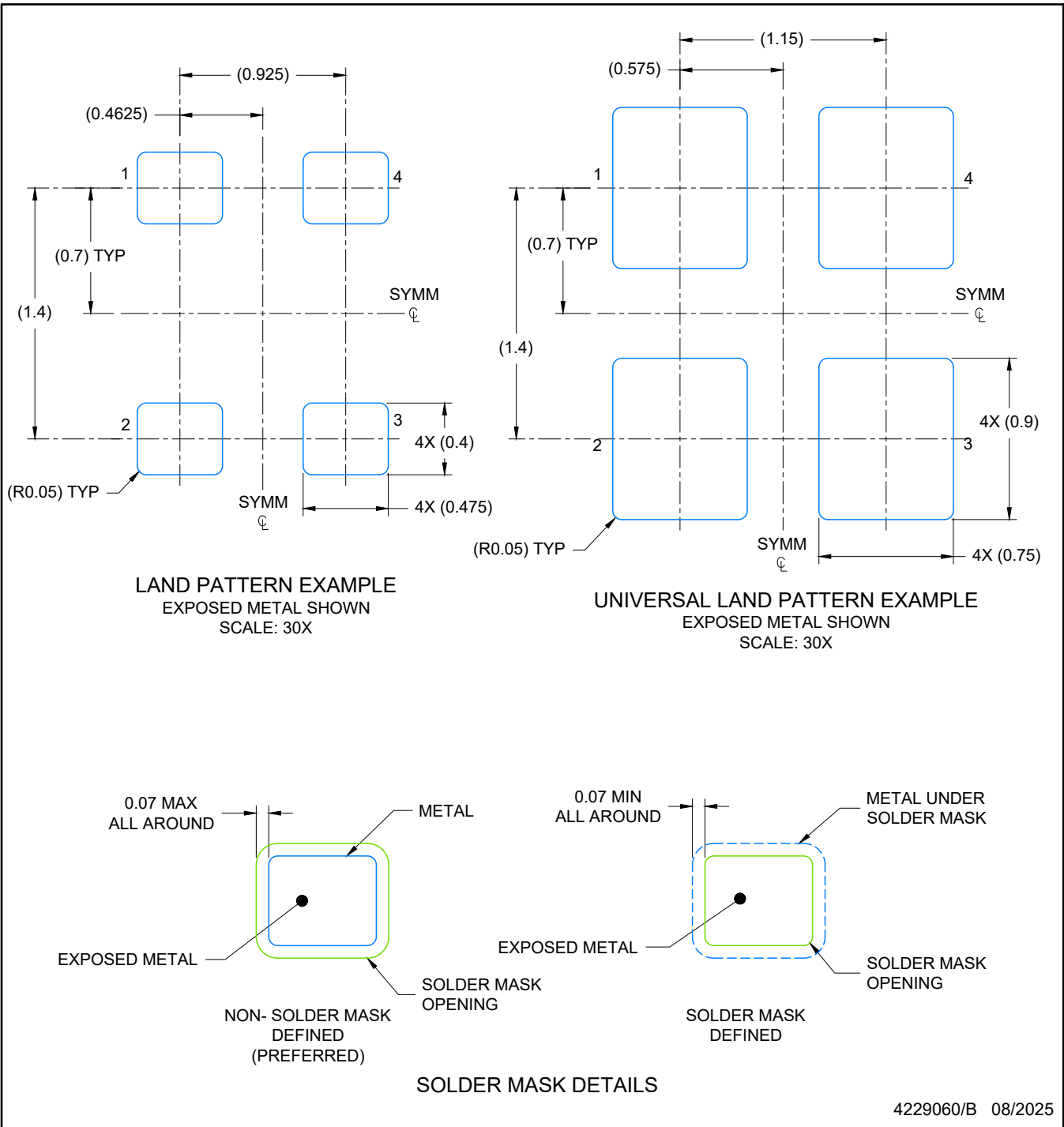
NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.



4229060/B 08/2025

NOTES: (continued)

- For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/sluea271) .

GENERIC PACKAGE VIEW

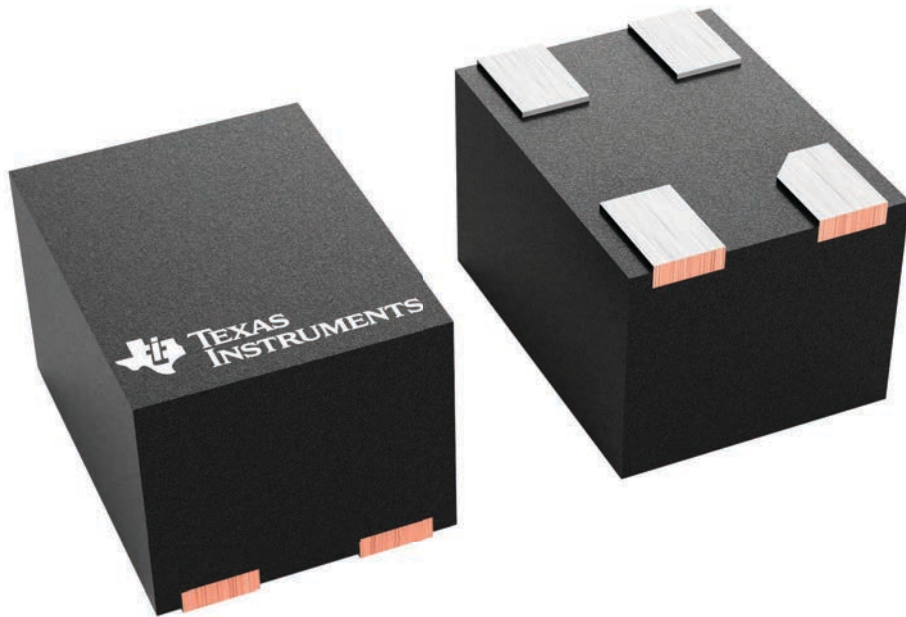
DLY 4

VSON - 1 mm max height

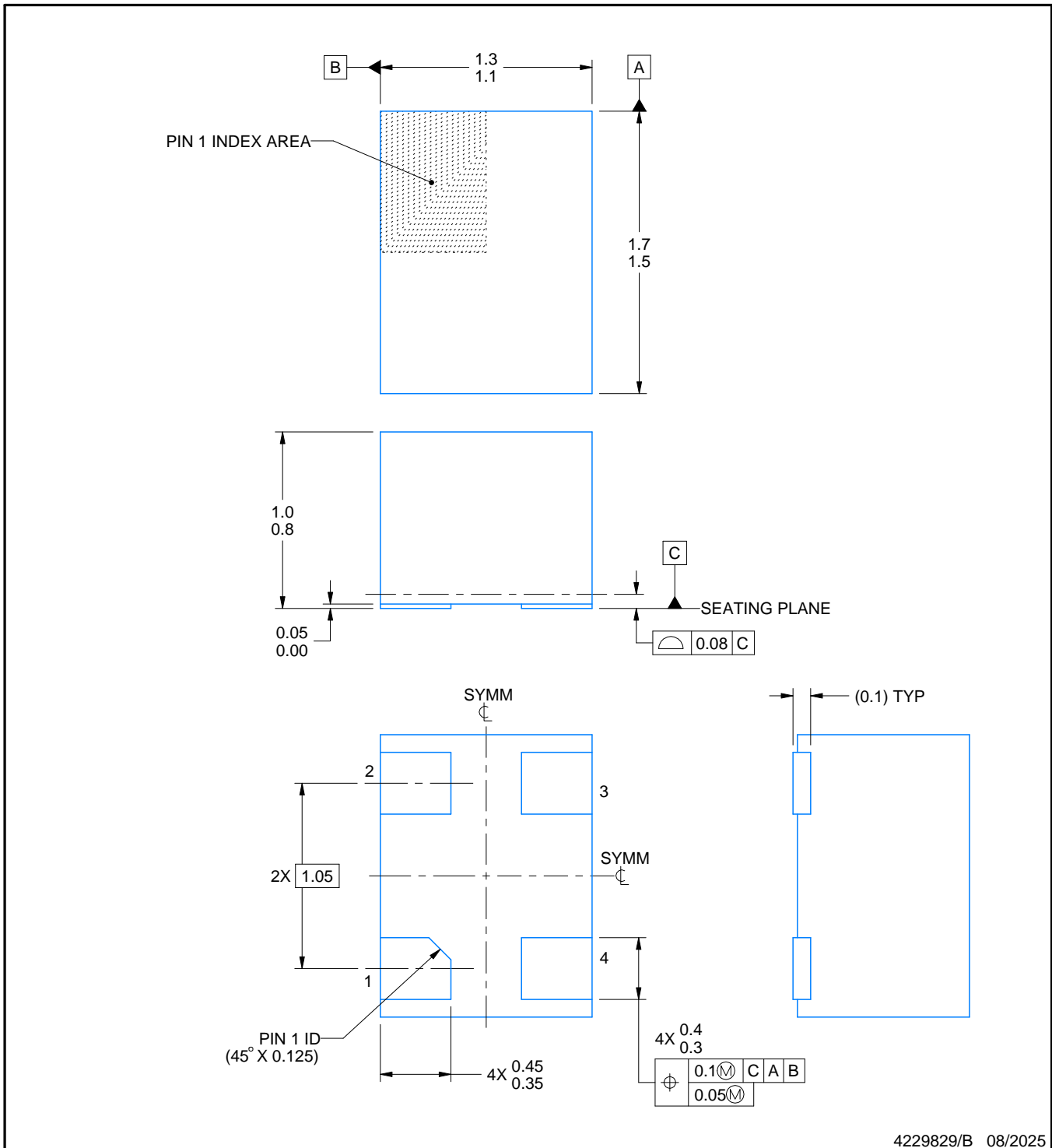
1.6 x 1.2, 0.7 mm pitch

PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4229365/A



4229829/B 08/2025

NOTES:

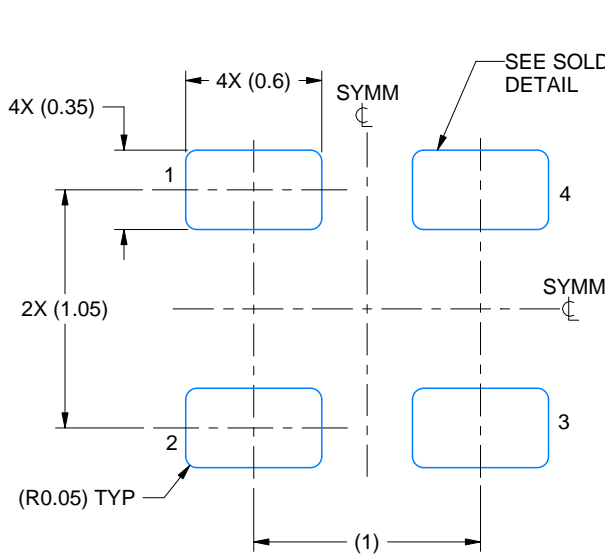
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

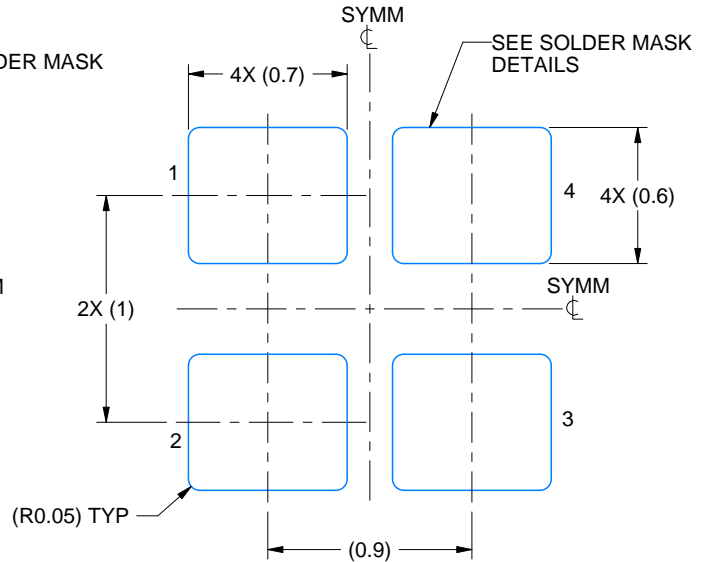
DLY0004C

VSON - 1 mm max height

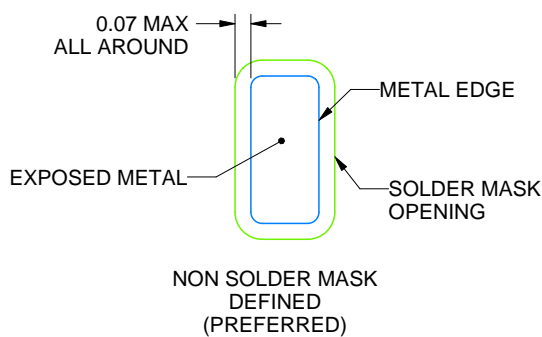
PLASTIC SMALL OUTLINE - NO LEAD



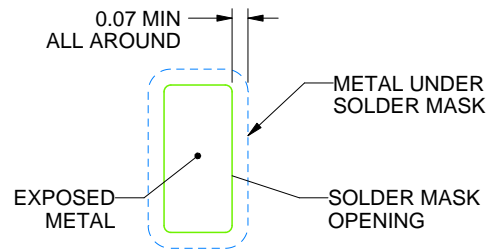
LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 30X



UNIVERSAL LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE: 30X



NON SOLDER MASK
DEFINED
(PREFERRED)



SOLDER MASK DEFINED

SOLDER MASK DETAILS

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NOTES: (continued)

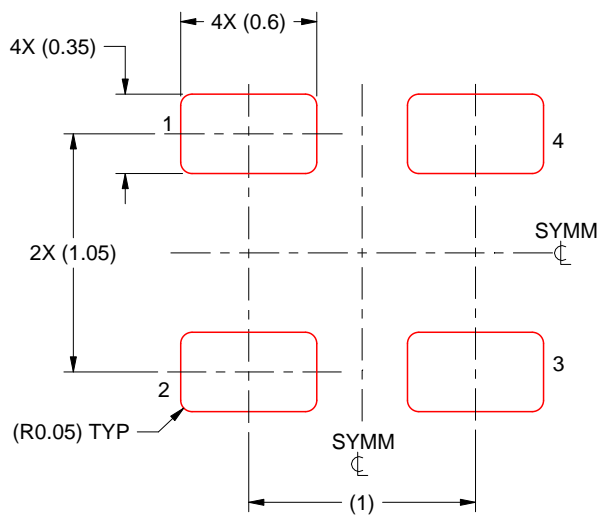
4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

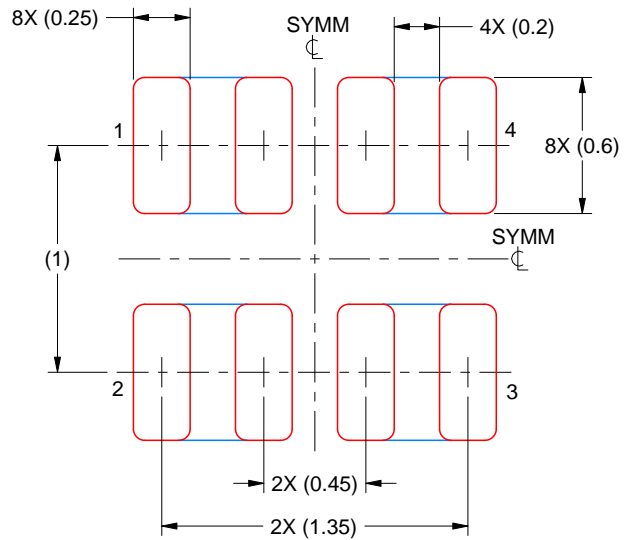
DLY0004C

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 30X



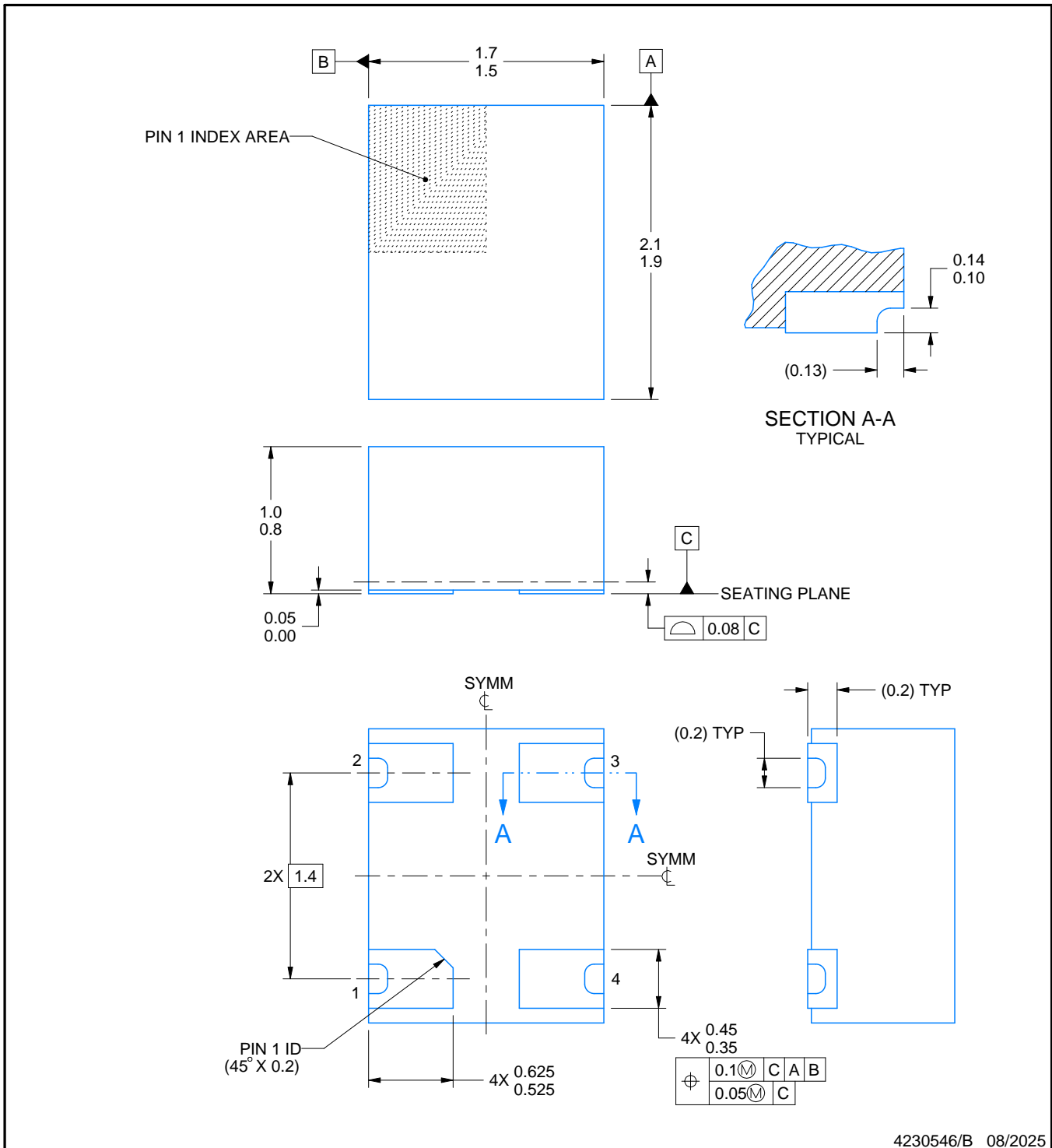
UNIVERSAL SOLDER PASTE EXAMPLE
BASED ON 0.125 MM THICK STENCIL
SCALE: 30X

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
ALL PADS: 71%

4229829/B 08/2025

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



4230546/B 08/2025

NOTES:

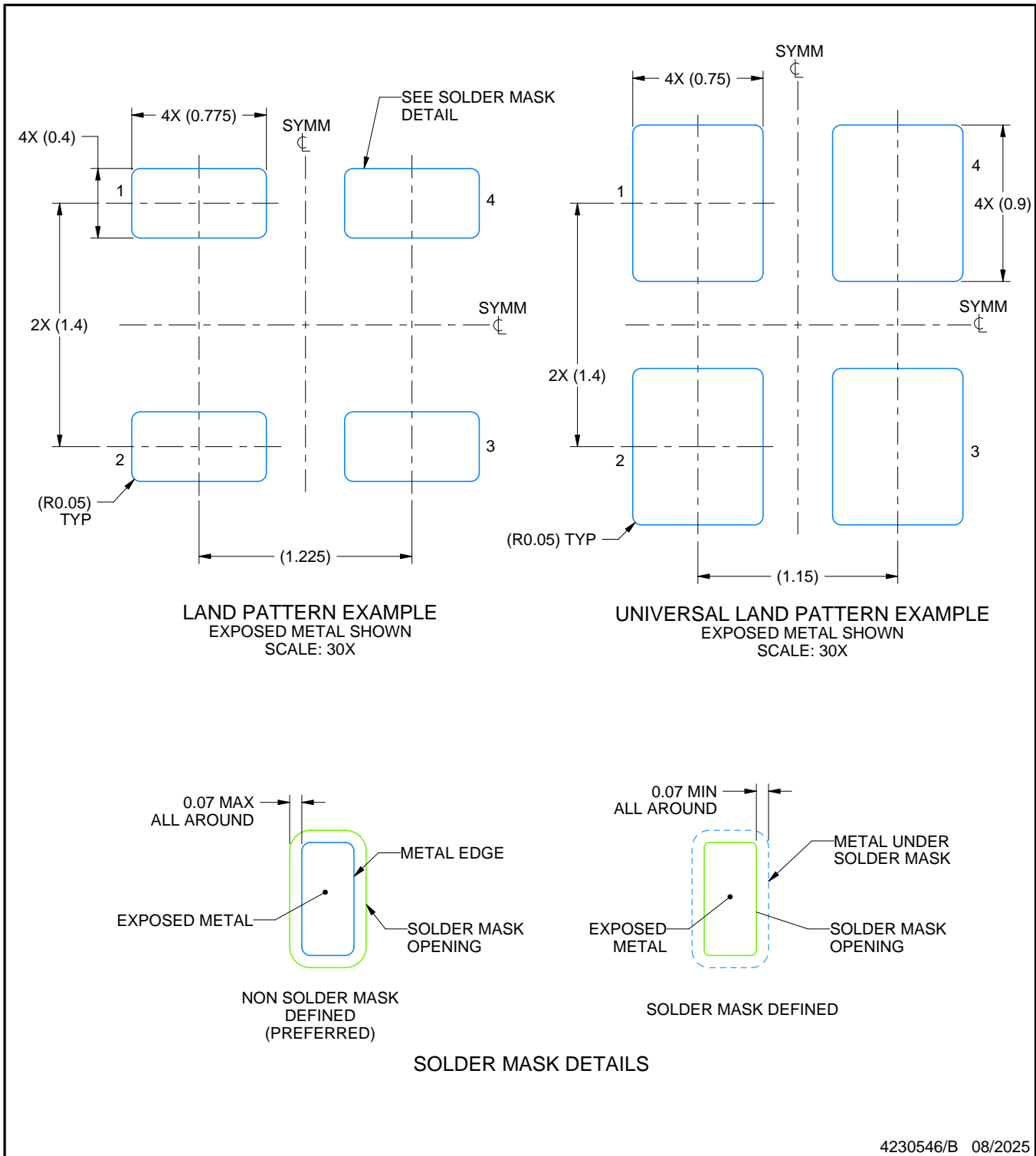
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

DLR0004A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



4230546/B 08/2025

NOTES: (continued)

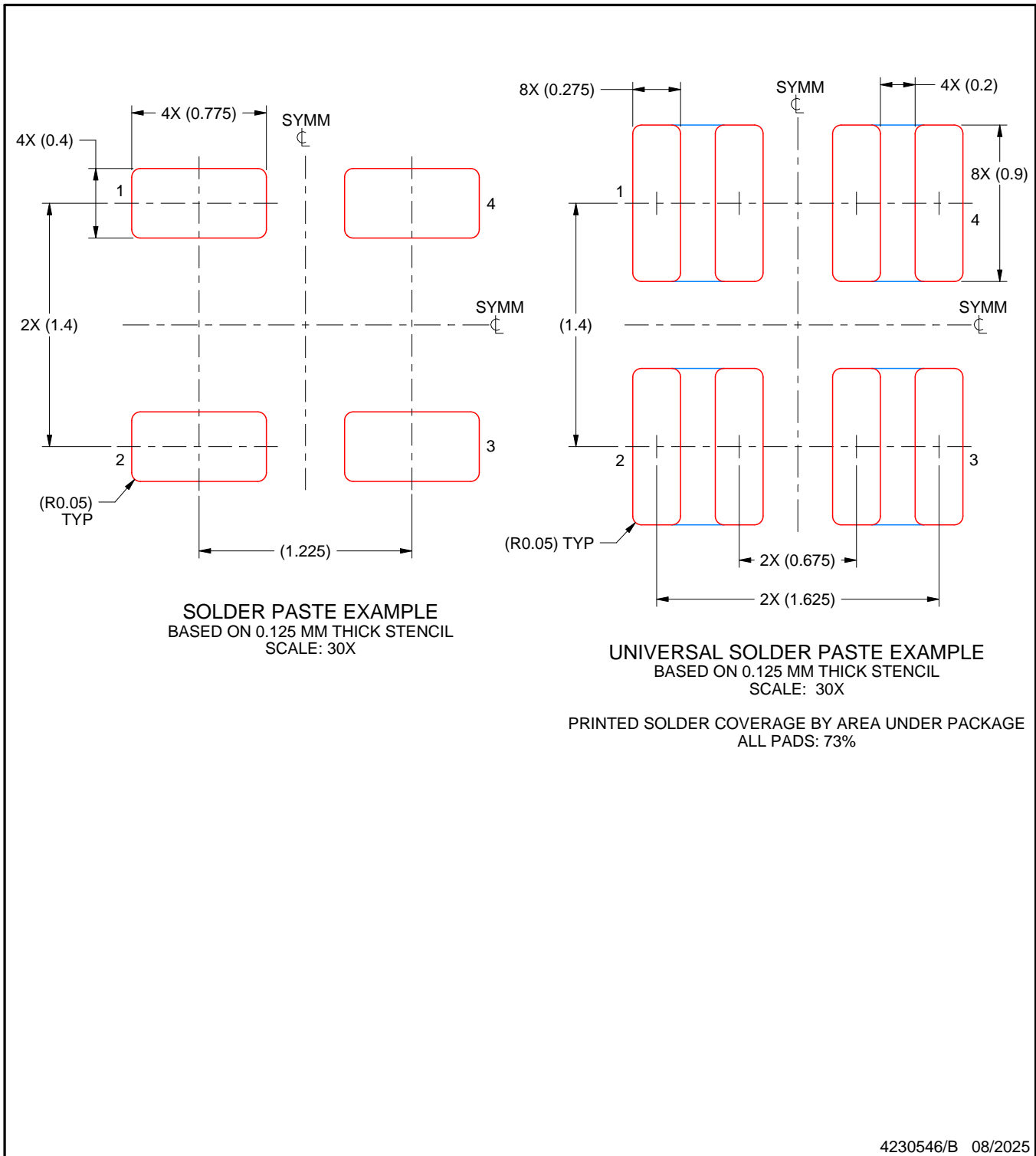
4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

DLR0004A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

GENERIC PACKAGE VIEW

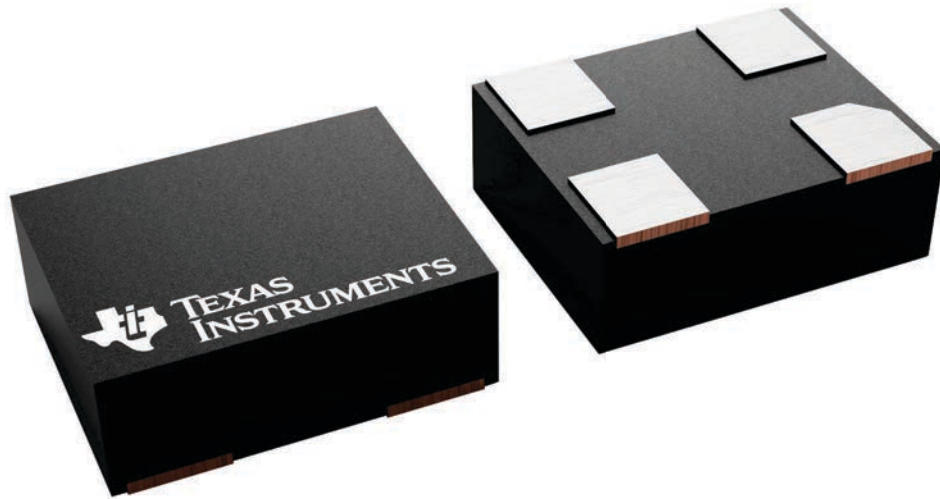
DLF 4

VSON - 1 mm max height

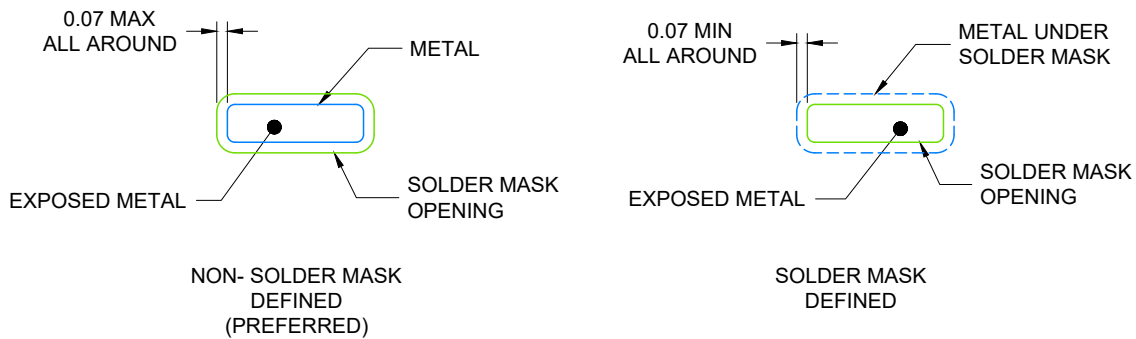
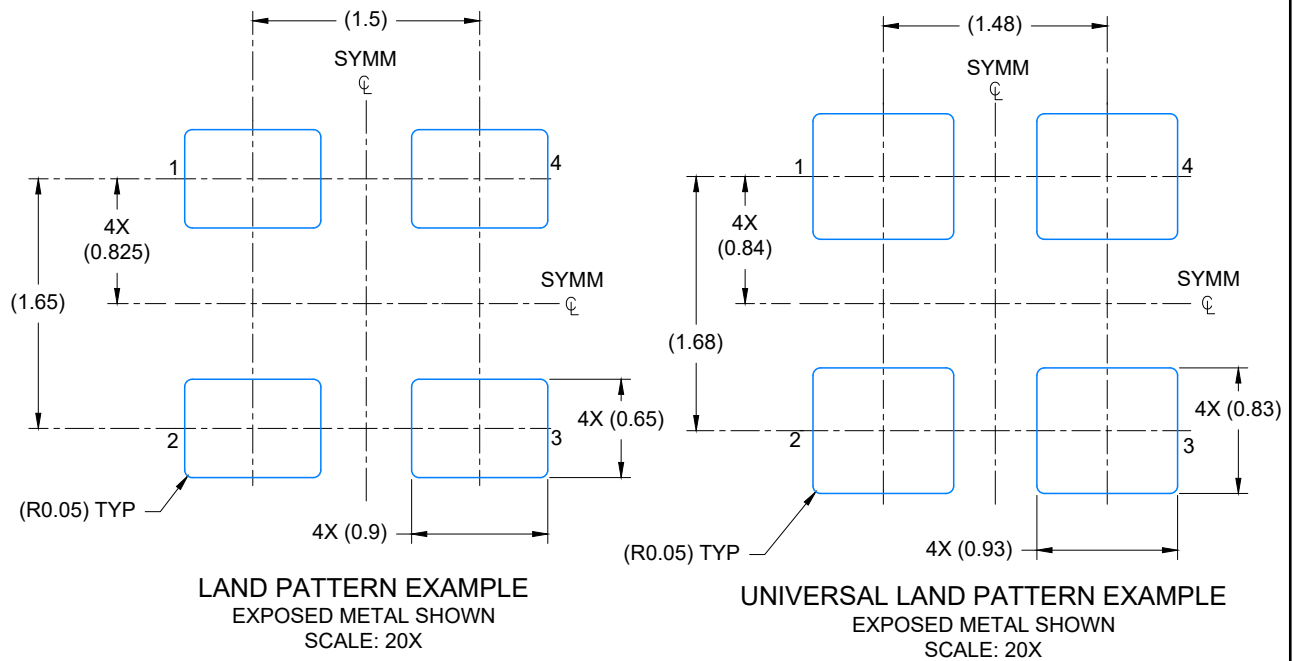
2 x 2.5, 1.65 mm pitch

PLASTIC QUAD FLAT PACK-NO LEAD

This image is a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.



4231598/A



SOLDER MASK DETAILS

4225946/E 08/2025

NOTES: (continued)

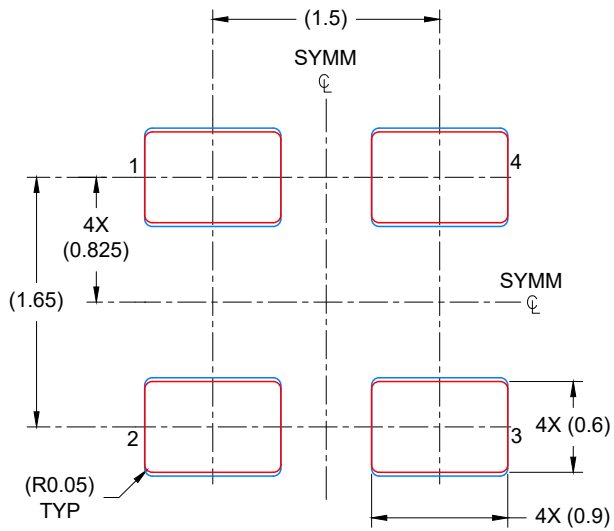
- For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271) .

EXAMPLE STENCIL DESIGN

VSON - 1 mm max height

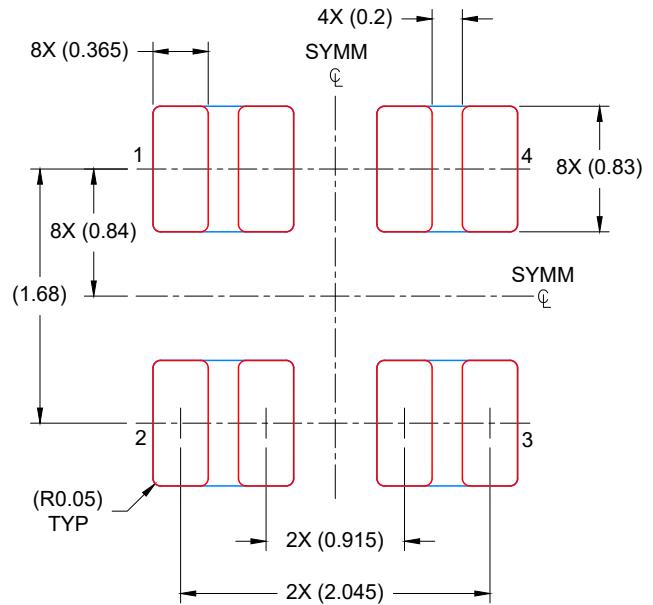
DLF0004A

PLASTIC QUAD FLAT PACK-NO LEAD



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
ALL PADS: 92%
SCALE: 20X



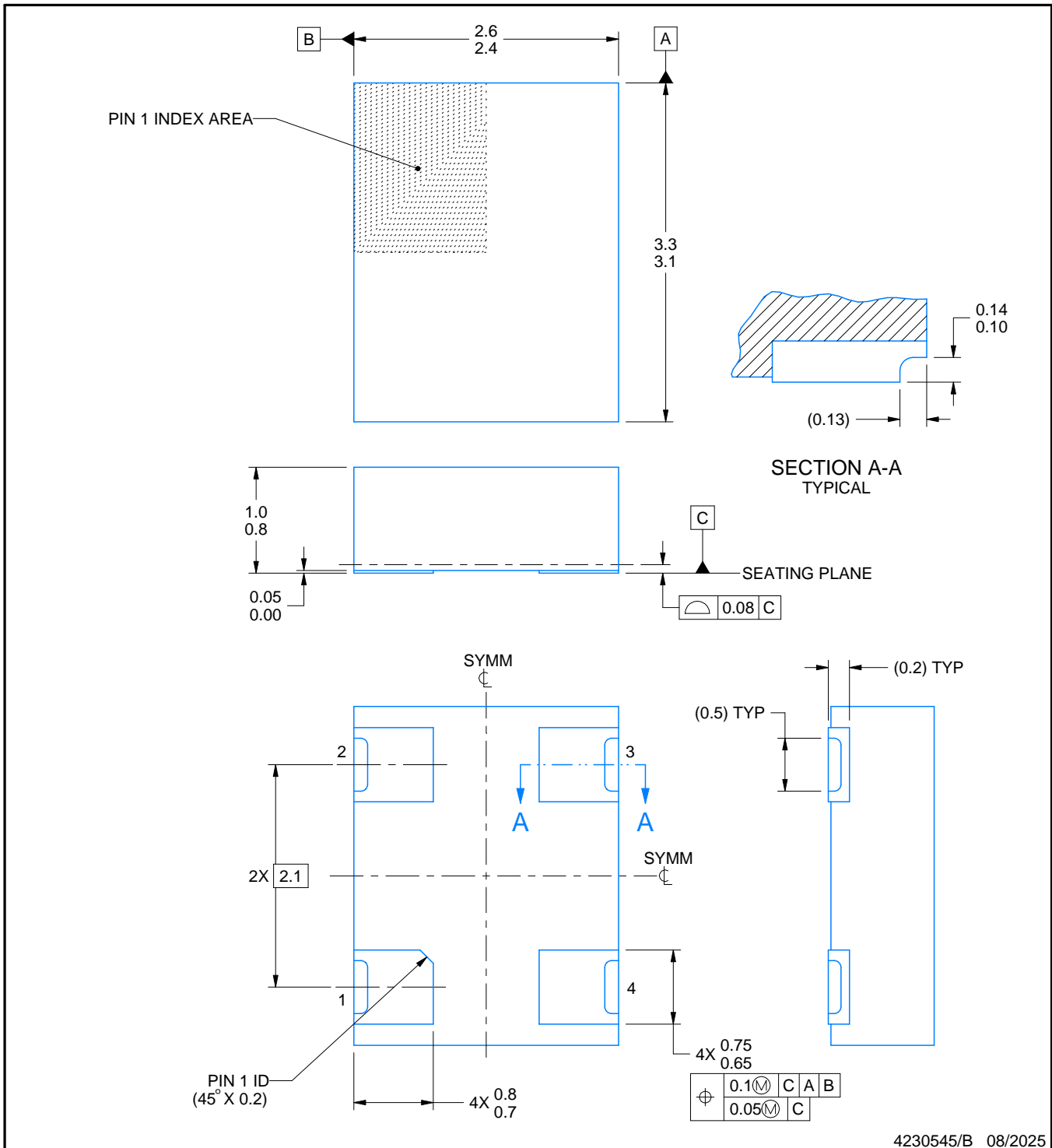
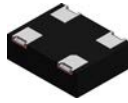
UNIVERSAL SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL

PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE
ALL PADS: 78%
SCALE: 20X

4225946/E 08/2025

NOTES: (continued)

4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



4230545/B 08/2025

NOTES:

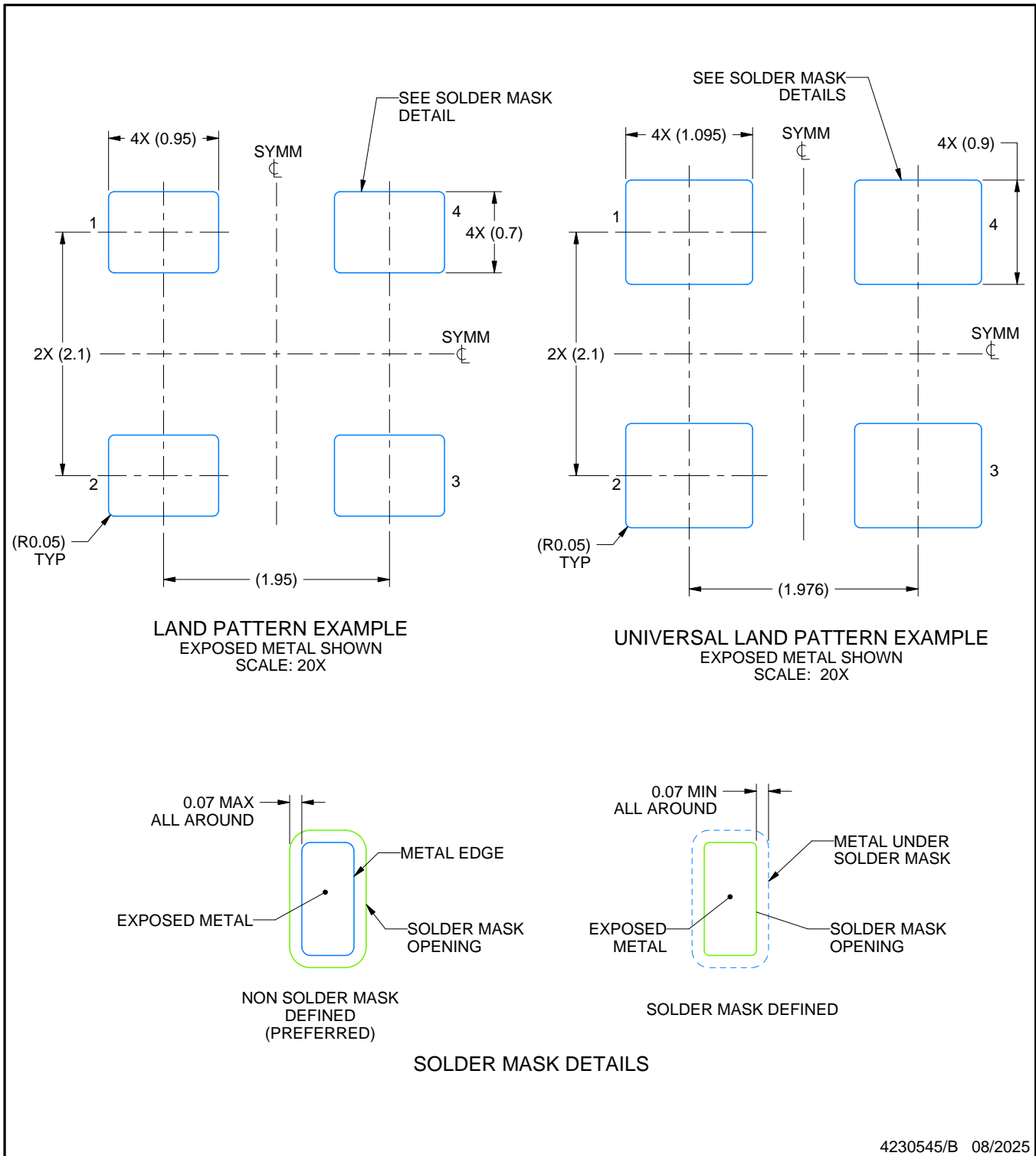
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

DLN0004A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



4230545/B 08/2025

NOTES: (continued)

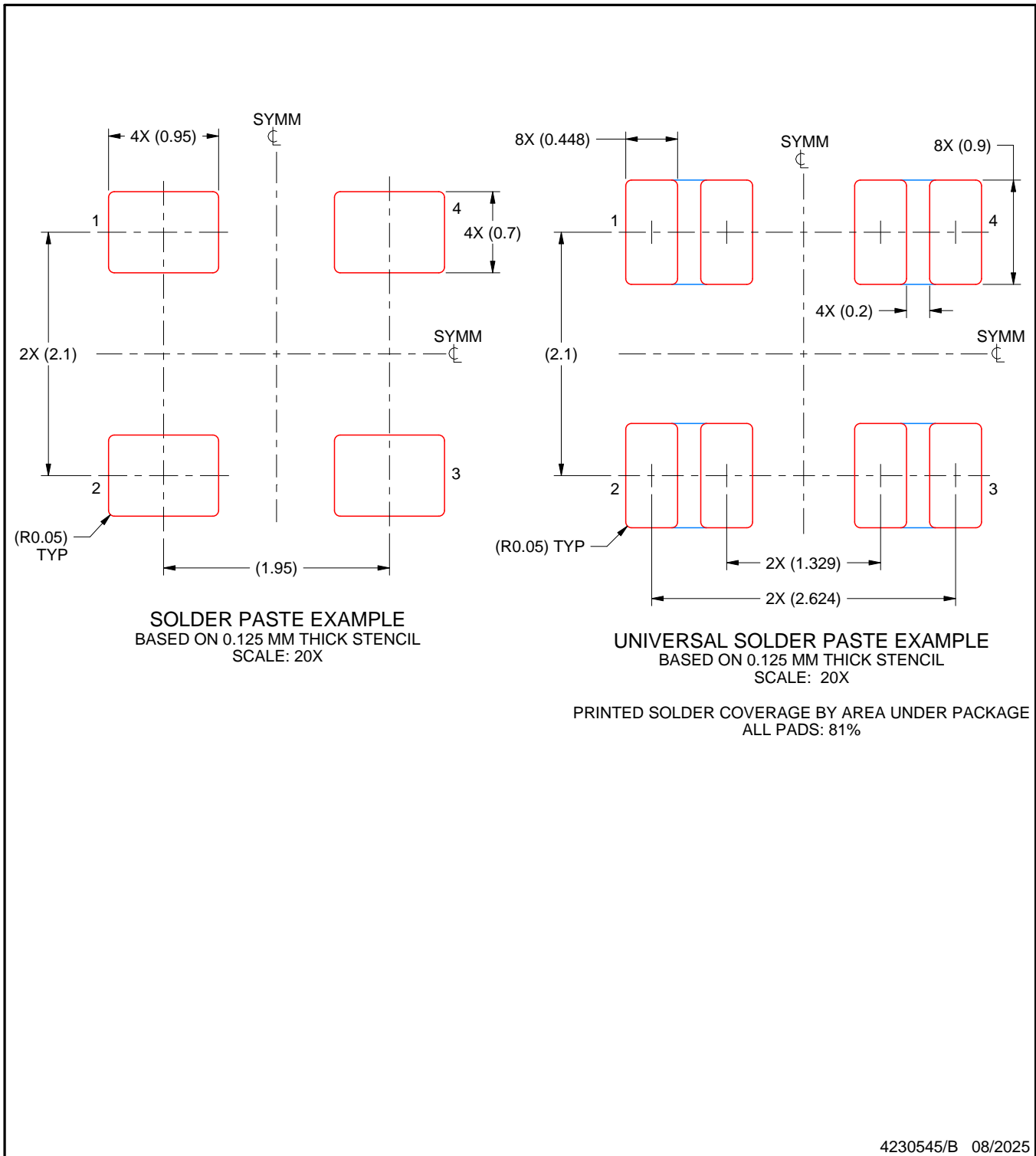
4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).

EXAMPLE STENCIL DESIGN

DLN0004A

VSON - 1 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



NOTES: (continued)

- 6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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